



# ANALOG DEVICES

# Quad, 12-/14-/16-Bit *nano*DACs with 5 ppm/°C On-Chip Reference, I<sup>2</sup>C Interface

## Data Sheet

## AD5625R/AD5645R/AD5665R, AD5625/AD5665

### FEATURES

Low power, smallest pin-compatible, quad *nano*DACs

**AD5625R/AD5645R/AD5665R**

12-/14-/16-bit *nano*DACs

On-chip, 2.5 V, 5 ppm/°C reference in TSSOP

On-chip, 2.5 V, 10 ppm/°C reference in LFCSP

On-chip, 1.25 V, 10 ppm/°C reference in LFCSP

**AD5625/AD5665**

12-/16-bit *nano*DACs

External reference only

3 mm × 3 mm, 10-lead LFCSP; 14-lead TSSOP; and

1.665 mm × 2.245 mm, 12-ball WLCSP

2.7 V to 5.5 V power supply

Guaranteed monotonic by design

Power-on reset to zero scale/midscale

Per channel power-down

Hardware LDAC and CLR functions

I<sup>2</sup>C-compatible serial interface supports standard (100 kHz),

fast (400 kHz), and high speed (3.4 MHz) modes

### APPLICATIONS

Process control

Data acquisition systems

Portable battery-powered instruments

Digital gain and offset adjustment

Programmable voltage and current sources

Programmable attenuators

### GENERAL DESCRIPTION

The **AD5625R/AD5645R/AD5665R** and **AD5625/AD5665** members of the *nano*DAC® family are low power, quad, 12-/14-/16-bit, buffered voltage-out DACs with/without an on-chip reference. All devices operate from a single 2.7 V to 5.5 V supply, are guaranteed monotonic by design, and have an I<sup>2</sup>C-compatible serial interface.

The **AD5625R/AD5645R/AD5665R** have an on-chip reference. The LFCSP versions of the **AD5625R/AD5645R/AD5665R** have a 1.25 V or 2.5 V, 10 ppm/°C reference, giving a full-scale output range of 2.5 V or 5 V; the TSSOP versions of the **AD5625R/AD5645R/AD5665R** have a 2.5 V, 5 ppm/°C reference, giving a full-scale output range of 5 V. The WLCSP has a 1.25 V reference. The on-chip reference is off at power-up, allowing the use of an external reference. The internal reference is enabled via a software write. The **AD5625/AD5665** require an external reference voltage to set the output range of the DAC.

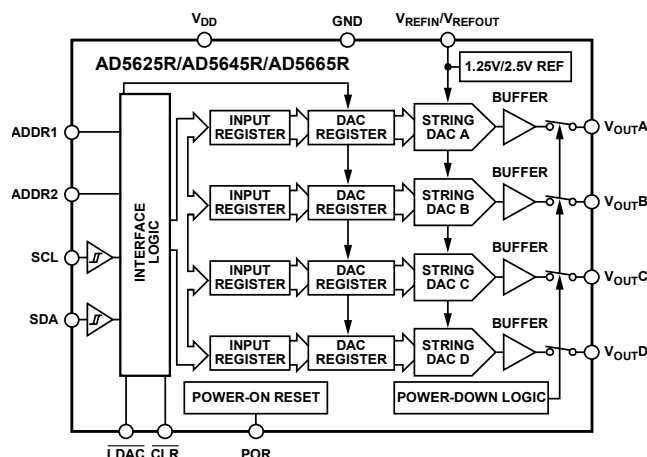
The device incorporates a power-on reset circuit that ensures that the DAC output powers up to 0 V (POR = GND) or midscale (POR = V<sub>DD</sub>) and remains there until a valid write occurs. The on-chip precision output amplifier enables rail-to-rail output swing.

Rev. F

**Document Feedback**

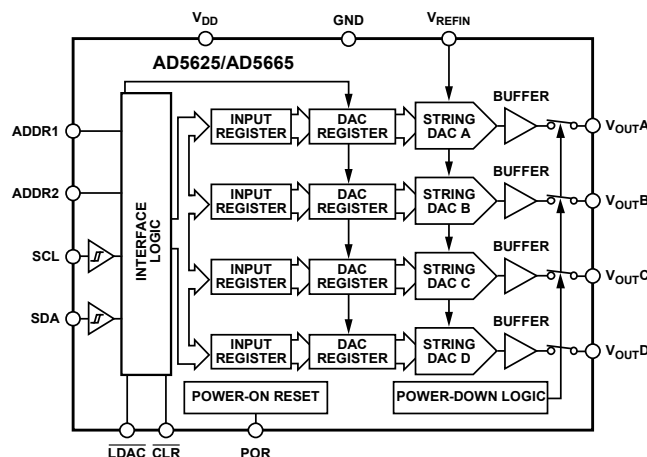
Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

### FUNCTIONAL BLOCK DIAGRAMS



NOTES  
1. THE FOLLOWING PINS ARE AVAILABLE ONLY ON 14-LEAD PACKAGE:  
ADDR2, LDAC, CLR, POR.

Figure 1. **AD5625R/AD5645R/AD5665R**



NOTES  
1. THE FOLLOWING PINS ARE AVAILABLE ONLY ON 14-LEAD PACKAGE:  
ADDR2, LDAC, CLR, POR.

Figure 2. **AD5625/AD5665**

The **AD5625R/AD5645R/AD5665R** and **AD5625/AD5665** use a 2-wire I<sup>2</sup>C-compatible serial interface that operates in standard (100 kHz), fast (400 kHz), and high speed (3.4 MHz) modes.

Table 1. Related Devices

| Device Number                                 | Description                                                                |
|-----------------------------------------------|----------------------------------------------------------------------------|
| <b>AD5025/AD5045/AD5065</b>                   | Dual 12-/14-/16-bit DACs                                                   |
| <b>AD5624R/AD5644R/AD5664R, AD5624/AD5664</b> | Quad SPI 12-/14-/16-bit DACs, with/without internal reference              |
| <b>AD5627R/AD5647R/AD5667R, AD5627/AD5667</b> | Dual I <sup>2</sup> C 12-/14-/16-bit DACs, with/without internal reference |
| <b>AD5666</b>                                 | Quad SPI 16-bit DAC with internal reference                                |

## TABLE OF CONTENTS

|                                                    |    |
|----------------------------------------------------|----|
| Features .....                                     | 1  |
| Applications .....                                 | 1  |
| General Description .....                          | 1  |
| Functional Block Diagrams .....                    | 1  |
| Revision History .....                             | 2  |
| Specifications .....                               | 3  |
| Specifications—AD5625R/AD5645R/AD5665R .....       | 3  |
| Specifications—AD5625/AD5665 .....                 | 5  |
| AC Characteristics .....                           | 7  |
| I <sup>2</sup> C Timing Specifications .....       | 8  |
| Absolute Maximum Ratings .....                     | 10 |
| ESD Caution .....                                  | 10 |
| Pin Configurations and Function Descriptions ..... | 11 |
| Typical Performance Characteristics .....          | 13 |
| Terminology .....                                  | 21 |
| Theory of Operation .....                          | 23 |
| Digital-to-Analog Converter (DAC) .....            | 23 |
| Resistor String .....                              | 23 |
| Output Amplifier .....                             | 23 |
| Internal Reference .....                           | 23 |

## REVISION HISTORY

### 10/2018—Rev. E to Rev. F

|                                           |    |
|-------------------------------------------|----|
| Changes to Serial Interface Section ..... | 24 |
| Moved Ordering Guide Section .....        | 34 |

### 1/2018—Rev. D to Rev. E

|                                                |    |
|------------------------------------------------|----|
| Change to Figure 6 .....                       | 11 |
| Added Figure 55; Renumbered Sequentially ..... | 20 |
| Change to Terminology Section .....            | 21 |
| Updated Outline Dimensions .....               | 33 |
| Changes to Ordering Guide .....                | 35 |

### 11/2015—Rev. C to Rev. D

|                                         |    |
|-----------------------------------------|----|
| Changes to Read Operation Section ..... | 24 |
|-----------------------------------------|----|

### 3/2013—Rev. B to Rev. C

|                                                                                |           |
|--------------------------------------------------------------------------------|-----------|
| Added 12-Ball WLCSP .....                                                      | Universal |
| Change to Features and General Description Sections .....                      | 1         |
| Changes to Reference Output (1.25 V), Reference TC<br>Parameter, Table 2 ..... | 4         |
| Added $\theta_{JA}$ Thermal Impedance, WLCSP Parameter, Table 6 ...            | 10        |
| Added Figure 8; Renumbered Sequentially .....                                  | 12        |
| Added Table 8; Renumbered Sequentially .....                                   | 12        |
| Changes to Internal Reference Section .....                                    | 23        |

|                                                                                                 |    |
|-------------------------------------------------------------------------------------------------|----|
| External Reference .....                                                                        | 24 |
| Serial Interface .....                                                                          | 24 |
| Write Operation .....                                                                           | 24 |
| Read Operation .....                                                                            | 24 |
| High Speed Mode .....                                                                           | 26 |
| Input Shift Register .....                                                                      | 26 |
| Multiple Byte Operation .....                                                                   | 26 |
| Broadcast Mode .....                                                                            | 28 |
| LDAC Function .....                                                                             | 28 |
| Power-Down Modes .....                                                                          | 30 |
| Power-On Reset and Software Reset .....                                                         | 31 |
| Internal Reference Setup (R Versions) .....                                                     | 31 |
| Applications Information .....                                                                  | 32 |
| Using a Reference as a Power Supply for the<br>AD5625R/AD5645R/AD5665R and AD5625/ AD5665 ..... | 32 |
| Bipolar Operation Using the AD5625R/ AD5645R/AD5665R<br>and AD5625/AD5665 .....                 | 32 |
| Power Supply Bypassing and Grounding .....                                                      | 32 |
| Outline Dimensions .....                                                                        | 33 |
| Ordering Guide .....                                                                            | 34 |

|                                                             |    |
|-------------------------------------------------------------|----|
| Changes to Serial Interface Section and Table 9 Title ..... | 24 |
| Changes to Figure 58 and Figure 60 Captions .....           | 25 |
| Updated Outline Dimensions .....                            | 33 |
| Changes to Ordering Guide .....                             | 35 |

### 12/2009—Rev. A to Rev. B

|                                                                                |    |
|--------------------------------------------------------------------------------|----|
| Changes to Features Section, General Description Section,<br>and Table 1 ..... | 1  |
| Changes to Table 2 .....                                                       | 3  |
| Changes to Internal Reference Section .....                                    | 22 |
| Updated Outline Dimensions .....                                               | 32 |
| Changes to Ordering Guide .....                                                | 33 |

### 6/2009—Rev. 0 to Rev. A

|                                                                                                                             |    |
|-----------------------------------------------------------------------------------------------------------------------------|----|
| Changes to Features and General Description Sections .....                                                                  | 1  |
| Changes to Table 2 .....                                                                                                    | 3  |
| Changes to Table 3 .....                                                                                                    | 5  |
| Changes to Digital-to-Analog Converter (DAC) Section, Added<br>Figure 54 and Figure 55, Renumbered Subsequent Figures ..... | 22 |
| Changes to Ordering Guide .....                                                                                             | 33 |

### 3/2007—Revision 0: Initial Version

## SPECIFICATIONS

## SPECIFICATIONS—AD5625R/AD5645R/AD5665R

$V_{DD} = 2.7 \text{ V to } 5.5 \text{ V}$ ;  $R_L = 2 \text{ k}\Omega$  to GND;  $C_L = 200 \text{ pF}$  to GND;  $V_{REFIN} = V_{DD}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 2.

| Parameter                           | Min    | A Grade<br>Typ | Max                                     | Min  | B Grade<br>Typ | Max                                     | Unit     | Test Conditions/Comments <sup>1</sup>                                               |
|-------------------------------------|--------|----------------|-----------------------------------------|------|----------------|-----------------------------------------|----------|-------------------------------------------------------------------------------------|
| STATIC PERFORMANCE <sup>2</sup>     |        |                |                                         |      |                |                                         |          |                                                                                     |
| AD5665R                             |        |                |                                         |      |                |                                         |          |                                                                                     |
| Resolution                          |        |                |                                         | 16   |                |                                         | Bits     | Guaranteed monotonic by design                                                      |
| Relative Accuracy                   |        |                |                                         |      | ±8             | ±16                                     | LSB      |                                                                                     |
| Differential Nonlinearity           |        |                |                                         |      |                | ±1                                      | LSB      |                                                                                     |
| AD5645R                             |        |                |                                         |      |                |                                         |          |                                                                                     |
| Resolution                          |        |                |                                         | 14   |                |                                         | Bits     | Guaranteed monotonic by design                                                      |
| Relative Accuracy                   |        |                |                                         |      | ±2             | ±4                                      | LSB      |                                                                                     |
| Differential Nonlinearity           |        |                |                                         |      |                | ±0.5                                    | LSB      |                                                                                     |
| AD5625R                             |        |                |                                         |      |                |                                         |          |                                                                                     |
| Resolution                          | 12     |                |                                         | 12   |                |                                         | Bits     | Guaranteed monotonic by design                                                      |
| Relative Accuracy                   |        | ±1             | ±4                                      |      | ±0.5           | ±1                                      | LSB      |                                                                                     |
| Differential Nonlinearity           |        |                | ±1                                      |      |                | ±0.25                                   | LSB      |                                                                                     |
| Zero-Code Error                     |        | 2              | 10                                      |      | 2              | 10                                      | mV       | All 0s loaded to DAC register                                                       |
| Offset Error                        |        | ±1             | ±10                                     |      | ±1             | ±10                                     | mV       |                                                                                     |
| Full-Scale Error                    |        | −0.1           | ±0.5                                    |      | −0.1           | ±0.5                                    | % FSR    | All 1s loaded to DAC register                                                       |
| Gain Error                          |        | ±0.1           | ±1.25                                   |      | ±0.1           | ±1                                      | % FSR    |                                                                                     |
| Zero-Code Error Drift               |        | ±2             |                                         |      | ±2             |                                         | μV/°C    |                                                                                     |
| Gain Temperature Coefficient        |        | ±2.5           |                                         |      | ±2.5           |                                         | ppm      | Of FSR/°C                                                                           |
| DC Power Supply Rejection Ratio     |        | −100           |                                         |      | −100           |                                         | dB       | DAC code = midscale;<br>V <sub>DD</sub> = 5 V ± 10%                                 |
| DC Crosstalk (External Reference)   |        | 15             |                                         |      | 15             |                                         | μV       | Due to full-scale output change,<br>R <sub>L</sub> = 2 kΩ to GND or V <sub>DD</sub> |
|                                     |        | 10             |                                         |      | 10             |                                         | μV/mA    | Due to load current change                                                          |
|                                     |        | 8              |                                         |      | 8              |                                         | μV       | Due to powering down (per channel)                                                  |
| DC Crosstalk (Internal Reference)   |        | 25             |                                         |      | 25             |                                         | μV       | Due to full-scale output change,<br>R <sub>L</sub> = 2 kΩ to GND or V <sub>DD</sub> |
|                                     |        | 20             |                                         |      | 20             |                                         | μV/mA    | Due to load current change                                                          |
|                                     |        | 10             |                                         |      | 10             |                                         | μV       | Due to powering down (per channel)                                                  |
| OUTPUT CHARACTERISTICS <sup>3</sup> |        |                |                                         |      |                |                                         |          |                                                                                     |
| Output Voltage Range                | 0<br>0 |                | V <sub>DD</sub><br>2 × V <sub>REF</sub> | 0    |                | V <sub>DD</sub><br>2 × V <sub>REF</sub> | V        | Internal reference disabled<br>Internal reference enabled                           |
| Capacitive Load Stability           |        | 2<br>10        |                                         |      | 2<br>10        |                                         | nF<br>nF | R <sub>L</sub> = ∞<br>R <sub>L</sub> = 2 kΩ                                         |
| DC Output Impedance                 |        | 0.5            |                                         |      | 0.5            |                                         | Ω        |                                                                                     |
| Short-Circuit Current               |        | 30             |                                         |      | 30             |                                         | mA       | V <sub>DD</sub> = 5 V                                                               |
| Power-Up Time                       |        | 4              |                                         |      | 4              |                                         | μs       | Coming out of power-down mode; V <sub>DD</sub> = 5 V                                |
| REFERENCE INPUTS                    |        |                |                                         |      |                |                                         |          |                                                                                     |
| Reference Current                   |        | 210            | 260                                     |      | 210            | 260                                     | μA       | V <sub>REF</sub> = V <sub>DD</sub> = 5.5 V                                          |
| Reference Input Range               | 0.75   |                | V <sub>DD</sub>                         | 0.75 |                | V <sub>DD</sub>                         | V        |                                                                                     |
| Reference Input Impedance           |        | 26             |                                         |      | 26             |                                         | kΩ       |                                                                                     |

| Parameter                                           | A Grade                |      |                        | B Grade                |            |                        | Unit         | Test Conditions/Comments <sup>1</sup>                                        |
|-----------------------------------------------------|------------------------|------|------------------------|------------------------|------------|------------------------|--------------|------------------------------------------------------------------------------|
|                                                     | Min                    | Typ  | Max                    | Min                    | Typ        | Max                    |              |                                                                              |
| REFERENCE OUTPUT (1.25 V)                           |                        |      |                        |                        |            |                        |              |                                                                              |
| Output Voltage                                      | 1.247                  |      | 1.253                  | 1.247                  |            | 1.253                  | V            | At ambient                                                                   |
| Reference TC <sup>3</sup>                           |                        | ±10  |                        |                        | ±10        |                        | ppm/°C       | TSSOP and LFCSP                                                              |
| Output Impedance                                    |                        | 7.5  |                        |                        | ±15<br>7.5 |                        | ppm/°C<br>kΩ | WLCSP                                                                        |
| REFERENCE OUTPUT (2.5 V)                            |                        |      |                        |                        |            |                        |              | V <sub>DD</sub> = 4.5 V to 5.5 V                                             |
| Output Voltage                                      | 2.495                  |      | 2.505                  | 2.495                  |            | 2.505                  | V            | At ambient                                                                   |
| Reference TC <sup>3</sup>                           |                        | ±10  |                        |                        | ±5         | ±10                    | ppm/°C       |                                                                              |
| Output Impedance                                    |                        | 7.5  |                        |                        | 7.5        |                        | kΩ           |                                                                              |
| LOGIC INPUTS (ADDRx, CLR, LDAC, POR) <sup>3</sup>   |                        |      |                        |                        |            |                        |              |                                                                              |
| I <sub>IN</sub> , Input Current                     |                        |      | ±1                     |                        |            | ±1                     | μA           |                                                                              |
| V <sub>INL</sub> , Input Low Voltage                |                        |      | 0.15 × V <sub>DD</sub> |                        |            | 0.15 × V <sub>DD</sub> | V            |                                                                              |
| V <sub>INH</sub> , Input High Voltage               | 0.85 × V <sub>DD</sub> |      |                        | 0.85 × V <sub>DD</sub> |            |                        | V            |                                                                              |
| C <sub>IN</sub> , Pin Capacitance                   |                        | 2    |                        |                        | 2          |                        | pF           |                                                                              |
| V <sub>HYST</sub> , Input Hysteresis                | 0.1 × V <sub>DD</sub>  |      |                        | 0.1 × V <sub>DD</sub>  |            |                        | V            |                                                                              |
| LOGIC INPUTS (SDA, SCL) <sup>3</sup>                |                        |      |                        |                        |            |                        |              |                                                                              |
| I <sub>IN</sub> , Input Current                     |                        |      | ±1                     |                        |            | ±1                     | μA           |                                                                              |
| V <sub>INL</sub> , Input Low Voltage                |                        |      | 0.3 × V <sub>DD</sub>  |                        |            | 0.3 × V <sub>DD</sub>  | V            |                                                                              |
| V <sub>INH</sub> , Input High Voltage               | 0.7 × V <sub>DD</sub>  |      |                        | 0.7 × V <sub>DD</sub>  |            |                        | V            |                                                                              |
| C <sub>IN</sub> , Pin Capacitance                   |                        | 2    |                        |                        | 2          |                        | pF           |                                                                              |
| V <sub>HYST</sub> , Input Hysteresis                | 0.1 × V <sub>DD</sub>  |      |                        | 0.1 × V <sub>DD</sub>  |            |                        | V            | High speed mode                                                              |
|                                                     | 0.05 × V <sub>DD</sub> |      |                        | 0.05 × V <sub>DD</sub> |            |                        | V            | Fast mode                                                                    |
| LOGIC OUTPUTS (SDA) <sup>3</sup>                    |                        |      |                        |                        |            |                        |              |                                                                              |
| V <sub>OL</sub> , Output Low Voltage                |                        |      | 0.4                    |                        |            | 0.4                    | V            | I <sub>SINK</sub> = 3 mA                                                     |
|                                                     |                        |      | 0.6                    |                        |            | 0.6                    | V            | I <sub>SINK</sub> = 6 mA                                                     |
| Floating-State Leakage Current                      |                        |      | ±1                     |                        |            | ±1                     | μA           |                                                                              |
| Floating-State Output Capacitance                   |                        | 2    |                        |                        | 2          |                        | pF           |                                                                              |
| POWER REQUIREMENTS                                  |                        |      |                        |                        |            |                        |              |                                                                              |
| V <sub>DD</sub>                                     | 2.7                    |      | 5.5                    | 2.7                    |            | 5.5                    | V            |                                                                              |
| I <sub>DD</sub> (Normal Mode) <sup>4</sup>          |                        |      |                        |                        |            |                        |              | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND, full-scale loaded |
| V <sub>DD</sub> = 4.5 V to 5.5 V                    |                        | 1.0  | 1.16                   |                        | 1.0        | 1.16                   | mA           | Internal reference off                                                       |
| V <sub>DD</sub> = 2.7 V to 3.6 V                    |                        | 0.9  | 1.05                   |                        | 0.9        | 1.05                   | mA           | Internal reference off                                                       |
| V <sub>DD</sub> = 4.5 V to 5.5 V                    |                        | 1.9  | 2.14                   |                        | 1.9        | 2.14                   | mA           | Internal reference on                                                        |
| V <sub>DD</sub> = 2.7 V to 3.6 V                    |                        | 1.4  | 1.59                   |                        | 1.4        | 1.59                   | mA           | Internal reference on                                                        |
| I <sub>DD</sub> (All Power-Down Modes) <sup>5</sup> |                        |      |                        |                        |            |                        |              |                                                                              |
| V <sub>DD</sub> = 2.7 V to 5.5 V                    |                        | 0.48 | 1                      |                        | 0.48       | 1                      | μA           | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND (LFCSP)            |
| V <sub>DD</sub> = 3.6 V to 5.5 V                    |                        | 0.48 | 1                      |                        | 0.48       | 1                      | μA           | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND (TSSOP)            |

<sup>1</sup> Temperature range of A and B grades is –40°C to +105°C.<sup>2</sup> Linearity calculated using a reduced code range: AD5665R (Code 512 to Code 65,024), AD5645R (Code 128 to Code 16,256), AD5625R (Code 32 to Code 4064). Output unloaded.<sup>3</sup> Guaranteed by design and characterization; not production tested.<sup>4</sup> Interface inactive. All DACs active. DAC outputs unloaded.<sup>5</sup> All DACs powered down. Power-down function is not available on 14-lead TSSOP devices when the device is powered with V<sub>DD</sub> < 3.6 V.

**SPECIFICATIONS—AD5625/AD5665**

$V_{DD} = 2.7\text{ V}$  to  $5.5\text{ V}$ ;  $R_L = 2\text{ k}\Omega$  to GND;  $C_L = 200\text{ pF}$  to GND;  $V_{REFIN} = V_{DD}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

**Table 3.**

| Parameter                                                      | B Grade                           |      |                        | Unit                               | Test Conditions/Comments <sup>1</sup>                                            |
|----------------------------------------------------------------|-----------------------------------|------|------------------------|------------------------------------|----------------------------------------------------------------------------------|
|                                                                | Min                               | Typ  | Max                    |                                    |                                                                                  |
| STATIC PERFORMANCE <sup>2</sup>                                |                                   |      |                        |                                    |                                                                                  |
| AD5665                                                         |                                   |      |                        |                                    |                                                                                  |
| Resolution                                                     | 16                                |      |                        | Bits                               | Guaranteed monotonic by design                                                   |
| Relative Accuracy                                              |                                   | ±8   | ±16                    | LSB                                |                                                                                  |
| Differential Nonlinearity                                      |                                   |      | ±1                     | LSB                                |                                                                                  |
| AD5625                                                         |                                   |      |                        |                                    |                                                                                  |
| Resolution                                                     | 12                                |      |                        | Bits                               | Guaranteed monotonic by design                                                   |
| Relative Accuracy                                              |                                   | ±0.5 | ±1                     | LSB                                |                                                                                  |
| Differential Nonlinearity                                      |                                   |      | ±0.25                  | LSB                                |                                                                                  |
| Zero-Code Error                                                |                                   | 2    | 10                     | mV                                 | All 0s loaded to DAC register                                                    |
| Offset Error                                                   |                                   | ±1   | ±10                    | mV                                 |                                                                                  |
| Full-Scale Error                                               |                                   | −0.1 | ±0.5                   | % FSR                              | All 1s loaded to DAC register                                                    |
| Gain Error                                                     |                                   | ±0.1 | ±1                     | % FSR                              |                                                                                  |
| Zero-Code Error Drift                                          |                                   | ±2   |                        | μV/°C                              |                                                                                  |
| Gain Temperature Coefficient                                   |                                   | ±2.5 |                        | ppm                                | Of FSR/°C                                                                        |
| DC Power Supply Rejection Ratio                                |                                   | −100 |                        | dB                                 | DAC code = midscale; V <sub>DD</sub> = 5 V ± 10%                                 |
| DC Crosstalk (External Reference)                              |                                   | 15   |                        | μV                                 | Due to full-scale output change, R <sub>L</sub> = 2 kΩ to GND or V <sub>DD</sub> |
|                                                                |                                   | 10   |                        | μV/mA                              | Due to load current change                                                       |
|                                                                |                                   | 8    |                        | μV                                 | Due to powering down (per channel)                                               |
|                                                                | DC Crosstalk (Internal Reference) | 25   |                        | μV                                 | Due to full-scale output change, R <sub>L</sub> = 2 kΩ to GND or V <sub>DD</sub> |
|                                                                |                                   | 20   |                        | μV/mA                              | Due to load current change                                                       |
|                                                                | 10                                |      | μV                     | Due to powering down (per channel) |                                                                                  |
| OUTPUT CHARACTERISTICS <sup>3</sup>                            |                                   |      |                        |                                    |                                                                                  |
| Output Voltage Range                                           | 0                                 |      | V <sub>DD</sub>        | V                                  |                                                                                  |
| Capacitive Load Stability                                      |                                   | 2    |                        | nF                                 | R <sub>L</sub> = ∞                                                               |
|                                                                |                                   | 10   |                        | nF                                 | R <sub>L</sub> = 2 kΩ                                                            |
| DC Output Impedance                                            |                                   | 0.5  |                        | Ω                                  |                                                                                  |
| Short-Circuit Current                                          |                                   | 30   |                        | mA                                 | V <sub>DD</sub> = 5 V                                                            |
| Power-Up Time                                                  |                                   | 4    |                        | μs                                 | Coming out of power-down mode; V <sub>DD</sub> = 5 V                             |
| REFERENCE INPUTS                                               |                                   |      |                        |                                    |                                                                                  |
| Reference Current                                              |                                   | 210  | 260                    | μA                                 | V <sub>REF</sub> = V <sub>DD</sub> = 5.5 V                                       |
| Reference Input Range                                          | 0.75                              |      | V <sub>DD</sub>        | V                                  |                                                                                  |
| Reference Input Impedance                                      |                                   | 26   |                        | kΩ                                 |                                                                                  |
| LOGIC INPUTS (ADDR <sub>x</sub> , CLR, LDAC, POR) <sup>3</sup> |                                   |      |                        |                                    |                                                                                  |
| I <sub>IN</sub> , Input Current                                |                                   |      | ±1                     | μA                                 |                                                                                  |
| V <sub>INL</sub> , Input Low Voltage                           |                                   |      | 0.15 × V <sub>DD</sub> | V                                  |                                                                                  |
| V <sub>INH</sub> , Input High Voltage                          | 0.85 × V <sub>DD</sub>            |      |                        | V                                  |                                                                                  |
| C <sub>IN</sub> , Pin Capacitance                              |                                   | 2    |                        | pF                                 |                                                                                  |
| V <sub>HYST</sub> , Input Hysteresis                           | 0.1 × V <sub>DD</sub>             |      |                        | V                                  |                                                                                  |
| LOGIC INPUTS (SDA, SCL) <sup>3</sup>                           |                                   |      |                        |                                    |                                                                                  |
| I <sub>IN</sub> , Input Current                                |                                   |      | ±1                     | μA                                 | High speed mode<br>Fast mode                                                     |
| V <sub>INL</sub> , Input Low Voltage                           |                                   |      | 0.3 × V <sub>DD</sub>  | V                                  |                                                                                  |
| V <sub>INH</sub> , Input High Voltage                          | 0.7 × V <sub>DD</sub>             |      |                        | V                                  |                                                                                  |
| C <sub>IN</sub> , Pin Capacitance                              |                                   | 2    |                        | pF                                 |                                                                                  |
| V <sub>HYST</sub> , Input Hysteresis                           | 0.1 × V <sub>DD</sub>             |      |                        | V                                  |                                                                                  |
|                                                                | 0.05 × V <sub>DD</sub>            |      |                        | V                                  |                                                                                  |

| Parameter                                           | B Grade |      |      | Unit | Test Conditions/Comments <sup>1</sup>                                        |
|-----------------------------------------------------|---------|------|------|------|------------------------------------------------------------------------------|
|                                                     | Min     | Typ  | Max  |      |                                                                              |
| LOGIC OUTPUTS (SDA) <sup>3</sup>                    |         |      |      |      |                                                                              |
| V <sub>OL</sub> , Output Low Voltage                |         |      | 0.4  | V    | I <sub>SINK</sub> = 3 mA                                                     |
|                                                     |         |      | 0.6  | V    | I <sub>SINK</sub> = 6 mA                                                     |
| Floating-State Leakage Current                      |         |      | ±1   | μA   |                                                                              |
| Floating-State Output Capacitance                   |         | 2    |      | pF   |                                                                              |
| POWER REQUIREMENTS                                  |         |      |      |      |                                                                              |
| V <sub>DD</sub>                                     | 2.7     |      | 5.5  | V    | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND, full-scale loaded |
| I <sub>DD</sub> (Normal Mode) <sup>4</sup>          |         |      |      |      |                                                                              |
| V <sub>DD</sub> = 4.5 V to 5.5 V                    |         | 1.0  | 1.16 | mA   |                                                                              |
| V <sub>DD</sub> = 2.7 V to 3.6 V                    |         | 0.9  | 1.05 | mA   |                                                                              |
| I <sub>DD</sub> (All Power-Down Modes) <sup>5</sup> |         |      |      |      |                                                                              |
| V <sub>DD</sub> = 2.7 V to 5.5 V                    |         | 0.48 | 1    | μA   | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND (LFCSP)            |
| V <sub>DD</sub> = 3.6 V to 5.5 V                    |         | 0.48 | 1    | μA   | V <sub>IH</sub> = V <sub>DD</sub> , V <sub>IL</sub> = GND (TSSOP)            |

<sup>1</sup> Temperature range of B grade is –40°C to +105°C.

<sup>2</sup> Linearity calculated using a reduced code range: [AD5665](#) (Code 512 to Code 65,024), [AD5625](#) (Code 32 to Code 4064). Output unloaded.

<sup>3</sup> Guaranteed by design and characterization; not production tested.

<sup>4</sup> Interface inactive. All DACs active. DAC outputs unloaded.

<sup>5</sup> All DACs powered down. Power-down function is not available on 14-lead TSSOP devices when the device is powered with V<sub>DD</sub> < 3.6 V.

## AC CHARACTERISTICS

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$ ;  $R_L = 2\text{ k}\Omega$  to GND;  $C_L = 200\text{ pF}$  to GND;  $V_{REFIN} = V_{DD}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 4.

| Parameter <sup>1, 2</sup>        | Min | Typ | Max | Unit                         | Test Conditions/Comments <sup>3</sup>                                   |
|----------------------------------|-----|-----|-----|------------------------------|-------------------------------------------------------------------------|
| Output Voltage Settling Time     |     |     |     |                              |                                                                         |
| AD5625R/AD5625                   |     | 3   | 4.5 | $\mu\text{s}$                | 1/4 to 3/4 scale settling to $\pm 0.5\text{ LSB}$                       |
| AD5645R                          |     | 3.5 | 5   | $\mu\text{s}$                | 1/4 to 3/4 scale settling to $\pm 0.5\text{ LSB}$                       |
| AD5665R/AD5665                   |     | 4   | 7   | $\mu\text{s}$                | 1/4 to 3/4 scale settling to $\pm 2\text{ LSB}$                         |
| Slew Rate                        |     | 1.8 |     | $\text{V}/\mu\text{s}$       |                                                                         |
| Digital-to-Analog Glitch Impulse |     |     |     |                              | 1 LSB change around major carry                                         |
|                                  |     | 15  |     | $\text{nV-s}$                | LFCSP                                                                   |
|                                  |     | 5   |     | $\text{nV-s}$                | TSSOP                                                                   |
| Digital Feedthrough              |     | 0.1 |     | $\text{nV-s}$                |                                                                         |
| Reference Feedthrough            |     | -90 |     | $\text{dB}$                  | $V_{REF} = 2\text{ V} \pm 0.1\text{ V p-p}$ , frequency 10 Hz to 20 MHz |
| Digital Crosstalk                |     | 0.1 |     | $\text{nV-s}$                |                                                                         |
| Analog Crosstalk                 |     | 1   |     | $\text{nV-s}$                | External reference                                                      |
|                                  |     | 4   |     | $\text{nV-s}$                | Internal reference                                                      |
| DAC-to-DAC Crosstalk             |     | 1   |     | $\text{nV-s}$                | External reference                                                      |
|                                  |     | 4   |     | $\text{nV-s}$                | Internal reference                                                      |
| Multiplying Bandwidth            |     | 340 |     | $\text{kHz}$                 | $V_{REF} = 2\text{ V} \pm 0.1\text{ V p-p}$                             |
| Total Harmonic Distortion        |     | -80 |     | $\text{dB}$                  | $V_{REF} = 2\text{ V} \pm 0.1\text{ V p-p}$ , frequency = 10 kHz        |
| Output Noise Spectral Density    |     | 120 |     | $\text{nV}/\sqrt{\text{Hz}}$ | DAC code = midscale, 1 kHz                                              |
|                                  |     | 100 |     | $\text{nV}/\sqrt{\text{Hz}}$ | DAC code = midscale, 10 kHz                                             |
| Output Noise                     |     | 15  |     | $\mu\text{V p-p}$            | 0.1 Hz to 10 Hz                                                         |

<sup>1</sup> Guaranteed by design and characterization; not production tested.

<sup>2</sup> See the Terminology section.

<sup>3</sup> Temperature range is  $-40^\circ\text{C}$  to  $+105^\circ\text{C}$ , typical at  $25^\circ\text{C}$ .

**I<sup>2</sup>C TIMING SPECIFICATIONS**

$V_{DD} = 2.7\text{ V to }5.5\text{ V}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ ,  $f_{SCL} = 3.4\text{ MHz}$ , unless otherwise noted (see Figure 3; high speed mode timing specification applies only to the [AD5625RBRUZ-2/AD5625RBRUZ-2REEL7](#) and [AD5665RBRUZ-2/AD5665RBRUZ-2REEL7](#)).

**Table 5.**

| Parameter              | Test Conditions <sup>1</sup>           | Min | Max  | Unit          | Description                                                                                        |
|------------------------|----------------------------------------|-----|------|---------------|----------------------------------------------------------------------------------------------------|
| $f_{SCL}$ <sup>2</sup> | Standard mode                          |     | 100  | kHz           | Serial clock frequency                                                                             |
|                        | Fast mode                              |     | 400  | kHz           |                                                                                                    |
|                        | High speed mode, $C_B = 100\text{ pF}$ |     | 3.4  | MHz           |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ |     | 1.7  | MHz           |                                                                                                    |
| $t_1$                  | Standard mode                          | 4   |      | $\mu\text{s}$ | $t_{HIGH}$ , SCL high time                                                                         |
|                        | Fast mode                              | 0.6 |      | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 60  |      | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 120 |      | ns            |                                                                                                    |
| $t_2$                  | Standard mode                          | 4.7 |      | $\mu\text{s}$ | $t_{LOW}$ , SCL low time                                                                           |
|                        | Fast mode                              | 1.3 |      | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 160 |      | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 320 |      | ns            |                                                                                                    |
| $t_3$                  | Standard mode                          | 250 |      | ns            | $t_{SU,DAT}$ , data setup time                                                                     |
|                        | Fast mode                              | 100 |      | ns            |                                                                                                    |
|                        | High speed mode                        | 10  |      | ns            |                                                                                                    |
| $t_4$                  | Standard mode                          | 0   | 3.45 | $\mu\text{s}$ | $t_{HD,DAT}$ , data hold time                                                                      |
|                        | Fast mode                              | 0   | 0.9  | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 0   | 70   | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 0   | 150  | ns            |                                                                                                    |
| $t_5$                  | Standard mode                          | 4.7 |      | $\mu\text{s}$ | $t_{SU,STA}$ , setup time for a repeated start condition                                           |
|                        | Fast mode                              | 0.6 |      | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode                        | 160 |      | ns            |                                                                                                    |
| $t_6$                  | Standard mode                          | 4   |      | $\mu\text{s}$ | $t_{HD,STA}$ , hold time (repeated) start condition                                                |
|                        | Fast mode                              | 0.6 |      | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode                        | 160 |      | ns            |                                                                                                    |
| $t_7$                  | Standard mode                          | 4.7 |      | $\mu\text{s}$ | $t_{BUF}$ , bus-free time between a stop and a start condition                                     |
|                        | Fast mode                              | 1.3 |      | $\mu\text{s}$ |                                                                                                    |
| $t_8$                  | Standard mode                          | 4   |      | $\mu\text{s}$ | $t_{SU,STO}$ , setup time for a stop condition                                                     |
|                        | Fast mode                              | 0.6 |      | $\mu\text{s}$ |                                                                                                    |
|                        | High speed mode                        | 160 |      | ns            |                                                                                                    |
|                        | Standard mode                          |     | 1000 | ns            |                                                                                                    |
| $t_9$                  | Fast mode                              |     | 300  | ns            | $t_{RDA}$ , rise time of SDA signal                                                                |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 10  | 80   | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 20  | 160  | ns            |                                                                                                    |
|                        | Standard mode                          |     | 300  | ns            |                                                                                                    |
| $t_{10}$               | Fast mode                              |     | 300  | ns            | $t_{FDA}$ , fall time of SDA signal                                                                |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 10  | 80   | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 20  | 160  | ns            |                                                                                                    |
|                        | Standard mode                          |     | 1000 | ns            |                                                                                                    |
| $t_{11}$               | Fast mode                              |     | 300  | ns            | $t_{RCL}$ , rise time of SCL signal                                                                |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 10  | 40   | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 20  | 80   | ns            |                                                                                                    |
|                        | Standard mode                          |     | 1000 | ns            |                                                                                                    |
| $t_{11A}$              | Fast mode                              |     | 300  | ns            | $t_{RCL1}$ , rise time of SCL signal after a repeated start condition and after an acknowledge bit |
|                        | High speed mode, $C_B = 100\text{ pF}$ | 10  | 80   | ns            |                                                                                                    |
|                        | High speed mode, $C_B = 400\text{ pF}$ | 20  | 160  | ns            |                                                                                                    |
|                        | Standard mode                          |     | 1000 | ns            |                                                                                                    |



| Parameter                    | Test Conditions <sup>1</sup>             | Min | Max | Unit | Description                                                                                                  |
|------------------------------|------------------------------------------|-----|-----|------|--------------------------------------------------------------------------------------------------------------|
| t <sub>12</sub>              | Standard mode                            |     | 300 | ns   | t <sub>FCL</sub> , fall time of SCL signal                                                                   |
|                              | Fast mode                                |     | 300 | ns   |                                                                                                              |
|                              | High speed mode, C <sub>B</sub> = 100 pF | 10  | 40  | ns   |                                                                                                              |
|                              | High speed mode, C <sub>B</sub> = 400 pF | 20  | 80  | ns   |                                                                                                              |
| t <sub>13</sub>              | Standard mode                            | 10  |     | ns   | $\overline{\text{LDAC}}$ pulse width low                                                                     |
|                              | Fast mode                                | 10  |     | ns   |                                                                                                              |
|                              | High speed mode                          | 10  |     | ns   |                                                                                                              |
| t <sub>14</sub>              | Standard mode                            | 300 |     | ns   | Falling edge of ninth SCL clock pulse of last byte of a valid write to $\overline{\text{LDAC}}$ falling edge |
|                              | Fast mode                                | 300 |     | ns   |                                                                                                              |
|                              | High speed mode                          | 30  |     | ns   |                                                                                                              |
| t <sub>15</sub>              | Standard mode                            | 20  |     | ns   | $\overline{\text{CLR}}$ pulse width low                                                                      |
|                              | Fast mode                                | 20  |     | ns   |                                                                                                              |
|                              | High speed mode                          | 20  |     | ns   |                                                                                                              |
| t <sub>SP</sub> <sup>3</sup> | Fast mode                                | 0   | 50  | ns   | Pulse width of spike suppressed                                                                              |
|                              | High speed mode                          | 0   | 10  | ns   |                                                                                                              |

<sup>1</sup> C<sub>B</sub> refers to the capacitance on the bus line.

<sup>2</sup> The SDA and SCL timing is measured with the input filters enabled. Switching off the input filters improves the transfer rate but has a negative effect on the EMC behavior of the device.

<sup>3</sup> Input filtering on the SCL and SDA inputs suppresses noise spikes that are less than 50 ns for fast mode or less than 10 ns for high speed mode.

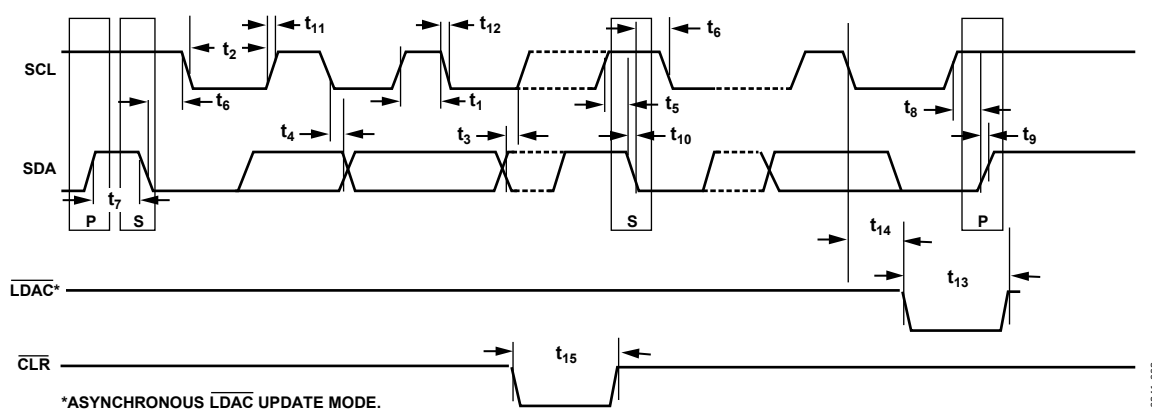


Figure 3. 2-Wire Serial Interface Timing Diagram

06341-003

## ABSOLUTE MAXIMUM RATINGS

$T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 6.

| Parameter                                            | Rating                                    |
|------------------------------------------------------|-------------------------------------------|
| $V_{DD}$ to GND                                      | $-0.3\text{ V to }+7\text{ V}$            |
| $V_{OUT}$ to GND                                     | $-0.3\text{ V to }V_{DD} + 0.3\text{ V}$  |
| $V_{REFIN}/V_{REFOUT}$ to GND                        | $-0.3\text{ V to }V_{DD} + 0.3\text{ V}$  |
| Digital Input Voltage to GND                         | $-0.3\text{ V to }V_{DD} + 0.3\text{ V}$  |
| Operating Temperature Range, Industrial              | $-40^\circ\text{C to }+105^\circ\text{C}$ |
| Storage Temperature Range                            | $-65^\circ\text{C to }+150^\circ\text{C}$ |
| Junction Temperature ( $T_J$ maximum)                | $150^\circ\text{C}$                       |
| Power Dissipation                                    | $(T_J \text{ max} - T_A)/\theta_{JA}$     |
| $\theta_{JA}$ Thermal Impedance                      |                                           |
| LFCSP (4-Layer Board)                                | $61^\circ\text{C/W}$                      |
| TSSOP                                                | $150.4^\circ\text{C/W}$                   |
| WLCSP                                                | $75^\circ\text{C/W}$                      |
| Reflow Soldering Peak Temperature,<br>RoHS Compliant | $260^\circ\text{C} \pm 5^\circ\text{C}$   |

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

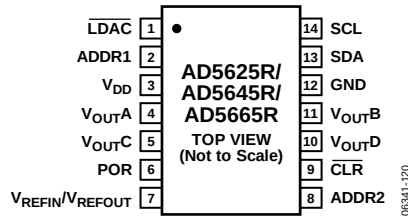


Figure 4. Pin Configuration (14-Lead TSSOP), R Suffix Version

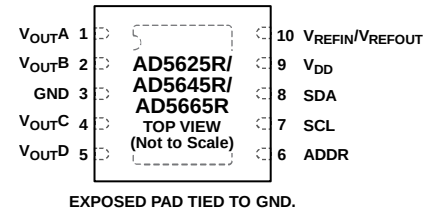


Figure 6. Pin Configuration (10-Lead LFCSP), R Suffix Version

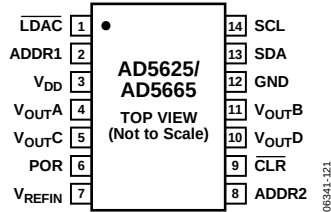


Figure 5. Pin Configuration (14-Lead TSSOP)

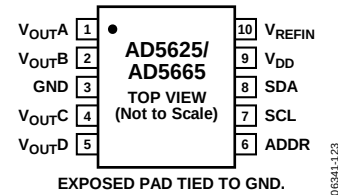


Figure 7. Pin Configuration (10-Lead LFCSP)

Table 7. Pin Function Descriptions

| Pin Number       |                  | Mnemonic                                | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|------------------|------------------|-----------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 14-Lead          | 10-Lead          |                                         |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| 1                | N/A <sup>1</sup> | LDAC                                    | Pulsing this pin low allows any or all DAC registers to be updated if the input registers have new data. This allows simultaneous update of all DAC outputs. Alternatively, this pin can be tied permanently low.                                                                                                                                                                                                                                                                                |
| 2                | N/A <sup>1</sup> | ADDR1                                   | Three-State Address Input. Sets the two least significant bits (Bit A1, Bit A0) of the 7-bit slave address (see Table 10).                                                                                                                                                                                                                                                                                                                                                                       |
| 3                | 9                | V <sub>DD</sub>                         | Power Supply Input. These devices can be operated from 2.7 V to 5.5 V, and the supply should be decoupled with a 10 μF capacitor in parallel with a 0.1 μF capacitor to GND.                                                                                                                                                                                                                                                                                                                     |
| 4                | 1                | V <sub>OUTA</sub>                       | Analog Output Voltage from DAC A. The output amplifier has rail-to-rail operation.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 5                | 4                | V <sub>OUTC</sub>                       | Analog Output Voltage from DAC C. The output amplifier has rail-to-rail operation.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 6                | N/A <sup>1</sup> | POR                                     | Power-On Reset Pin. Tying the POR pin to GND powers up the device to 0 V. Tying the POR pin to V <sub>DD</sub> powers up the device to midscale.                                                                                                                                                                                                                                                                                                                                                 |
| 7                | 10               | V <sub>REFIN</sub> /V <sub>REFOUT</sub> | The AD5625R/AD5645R/AD5665R have a common pin for reference input and reference output. When using the internal reference, this is the reference output pin. When using an external reference, this is the reference input pin. The default for this pin is as a reference input. (The internal reference and reference output are only available on R suffix versions.) The AD5625/AD5665 have a reference input pin only.                                                                      |
| 8                | N/A <sup>1</sup> | ADDR2                                   | Three-State Address Input. Sets Bit A3 and Bit A2 of the 7-bit slave address (see Table 10).                                                                                                                                                                                                                                                                                                                                                                                                     |
| 9                | N/A <sup>1</sup> | CLR                                     | Asynchronous Clear Input. The CLR input is falling-edge sensitive. While CLR is low, all LDAC pulses are ignored. When CLR is activated, zero scale is loaded to all input and DAC registers. This clears the output to 0 V. The device exits clear code mode on the falling edge of the ninth clock pulse of the last byte of the valid write. If CLR is activated during a write sequence, the write is aborted. If CLR is activated during high speed mode, the device exits high speed mode. |
| 10               | 5                | V <sub>OUTD</sub>                       | Analog Output Voltage from DAC D. The output amplifier has rail-to-rail operation.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 11               | 2                | V <sub>OUTB</sub>                       | Analog Output Voltage from DAC B. The output amplifier has rail-to-rail operation.                                                                                                                                                                                                                                                                                                                                                                                                               |
| 12               | 3                | GND                                     | Ground Reference Point for All Circuitry on the Device.                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 13               | 8                | SDA                                     | Serial Data Line. This is used in conjunction with the SCL line to clock data into or out of the 16-bit input register. It is a bidirectional, open-drain data line that should be pulled to the supply with an external pull-up resistor.                                                                                                                                                                                                                                                       |
| 14               | 7                | SCL                                     | Serial Clock Line. This is used in conjunction with the SDA line to clock data into or out of the 16-bit input register.                                                                                                                                                                                                                                                                                                                                                                         |
| N/A <sup>1</sup> | 6                | ADDR                                    | Three-State Address Input. Sets the two least significant bits (Bit A1, Bit A0) of the 7-bit slave address (see Table 9).                                                                                                                                                                                                                                                                                                                                                                        |
|                  | EPAD             |                                         | For the 10-lead LFCSP, the exposed pad must be tied to GND.                                                                                                                                                                                                                                                                                                                                                                                                                                      |

<sup>1</sup> N/A means not applicable.

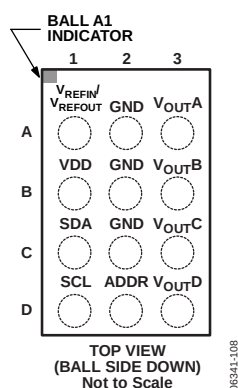


Figure 8. Pin Configuration (12-Ball WLCSP)

Table 8. Pin Function Descriptions

| Pin No.    | Mnemonic               | Description                                                                                                                                                                                                                                                                      |
|------------|------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| A1         | $V_{REFIN}/V_{REFOUT}$ | The <a href="#">AD5665R</a> has a common pin for reference input and reference output. When using the internal reference, this is the reference output pin. When using an external reference, this is the reference input pin. The default for this pin is as a reference input. |
| A2, B2, C2 | GND                    | Ground Reference Point for All Circuitry on the Device.                                                                                                                                                                                                                          |
| A3         | $V_{OUTA}$             | Analog Output Voltage from DAC A. The output amplifier has rail-to-rail operation.                                                                                                                                                                                               |
| B1         | $V_{DD}$               | Power Supply Input. The <a href="#">AD5665R</a> can be operated from 2.7 V to 5.5 V, and the supply should be decoupled with a 10 $\mu$ F capacitor in parallel with a 0.1 $\mu$ F capacitor to GND.                                                                             |
| B3         | $V_{OUTB}$             | Analog Output Voltage from DAC B. The output amplifier has rail-to-rail operation.                                                                                                                                                                                               |
| C1         | SDA                    | Serial Data Line. This is used in conjunction with the SCL line to clock data into or out of the 16-bit input register. It is a bidirectional, open-drain data line that should be pulled to the supply with an external pull-up resistor.                                       |
| C3         | $V_{OUTC}$             | Analog Output Voltage from DAC C. The output amplifier has rail-to-rail operation.                                                                                                                                                                                               |
| D1         | SCL                    | Serial Clock Line. This is used in conjunction with the SDA line to clock data into or out of the 16-bit input register.                                                                                                                                                         |
| D2         | ADDR                   | Three-State Address Input. Sets the two least significant bits (Bit A1, Bit A0) of the 7-bit slave address (see Table 9).                                                                                                                                                        |
| D3         | $V_{OUTD}$             | Analog Output Voltage from DAC D. The output amplifier has rail-to-rail operation.                                                                                                                                                                                               |

## TYPICAL PERFORMANCE CHARACTERISTICS

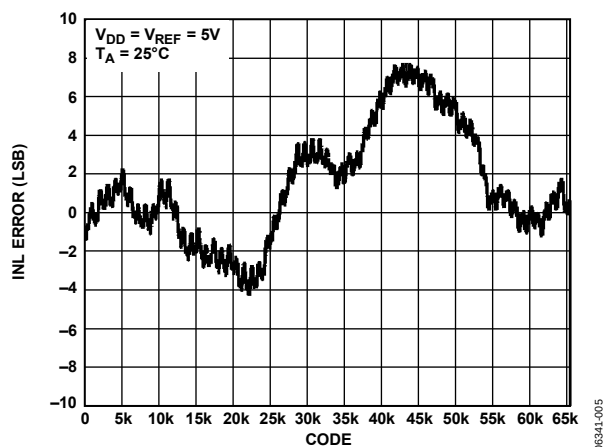


Figure 9. INL, AD5665, External Reference

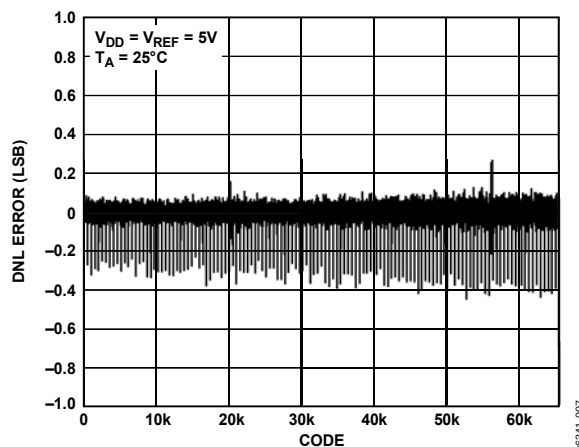


Figure 12. DNL, AD5665, External Reference

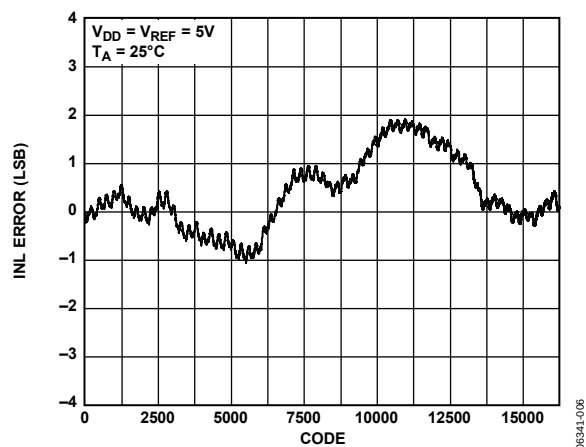


Figure 10. INL, AD5645R, External Reference

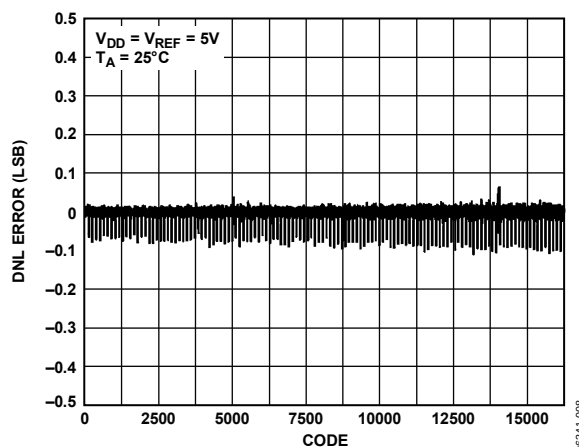


Figure 13. DNL, AD5645R, External Reference

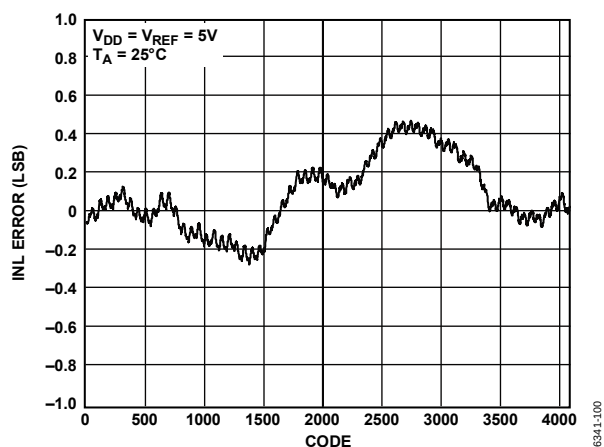


Figure 11. INL, AD5625, External Reference

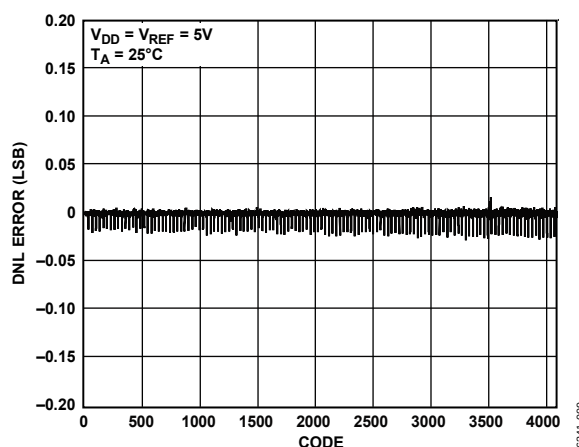


Figure 14. DNL, AD5625, External Reference

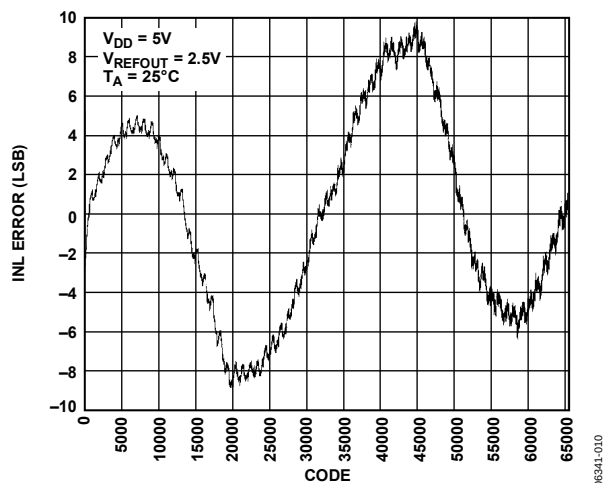


Figure 15. INL, AD5665R, 2.5 V Internal Reference

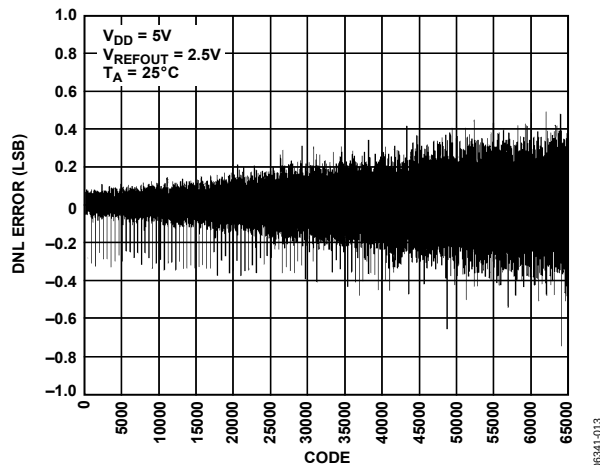


Figure 18. DNL, AD5665R, 2.5 V Internal Reference

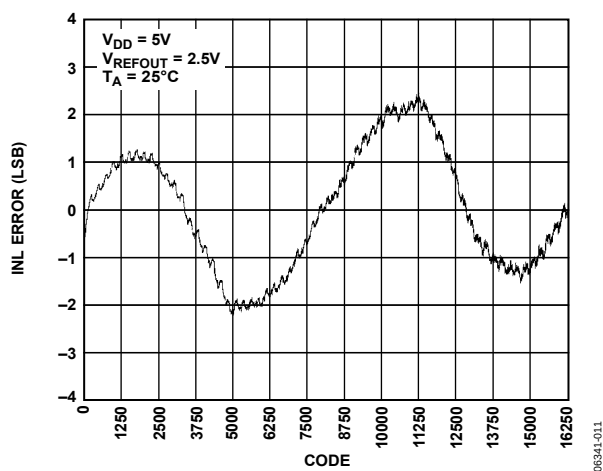


Figure 16. INL, AD5645R, 2.5 V Internal Reference

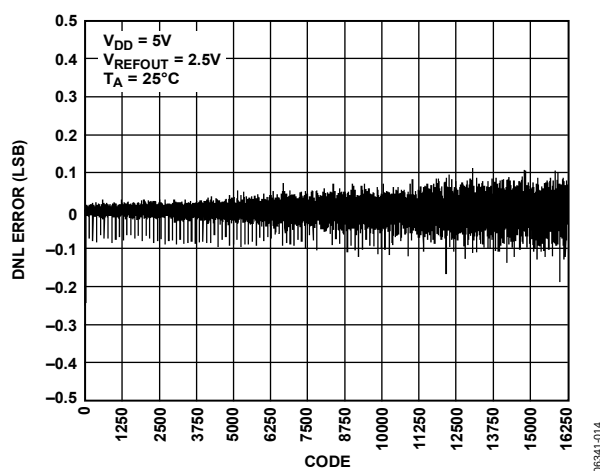


Figure 19. DNL, AD5645R, 2.5 V Internal Reference

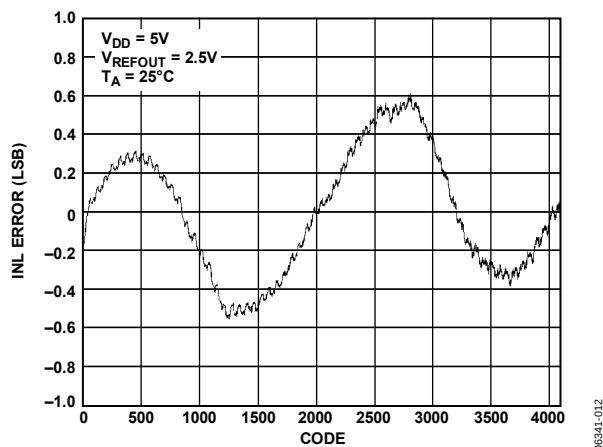


Figure 17. INL, AD5625R, 2.5 V Internal Reference

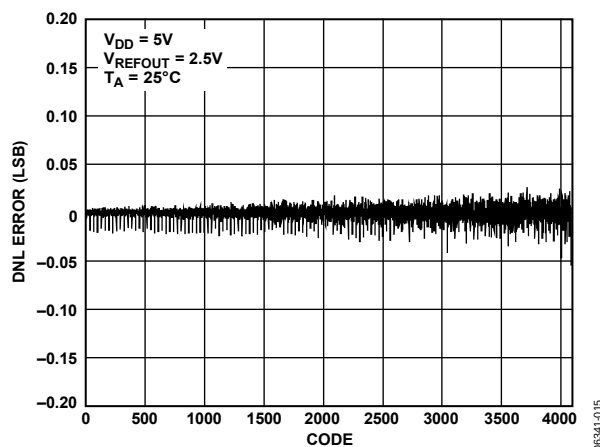


Figure 20. DNL, AD5625R, 2.5 V Internal Reference

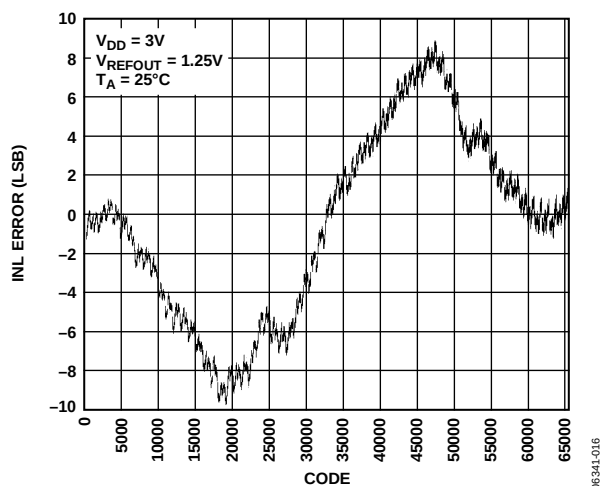


Figure 21. INL, AD5665R, 1.25 V Internal Reference

06341-016

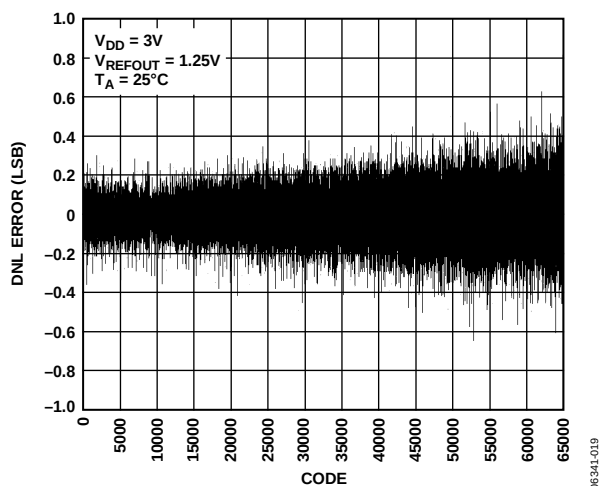


Figure 24. DNL, AD5665R, 1.25 V Internal Reference

06341-019

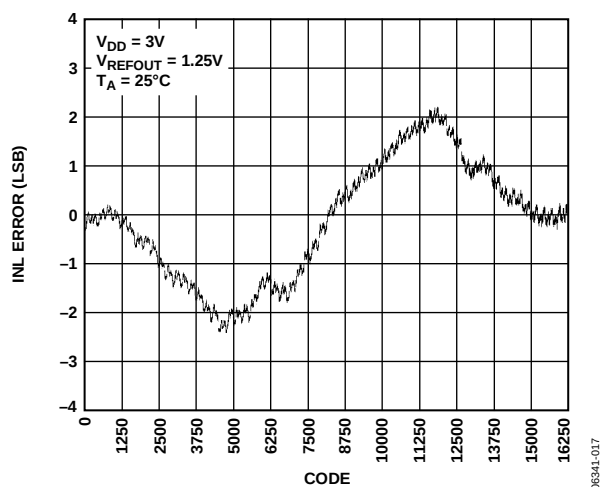


Figure 22. INL, AD5645R, 1.25 V Internal Reference

06341-017

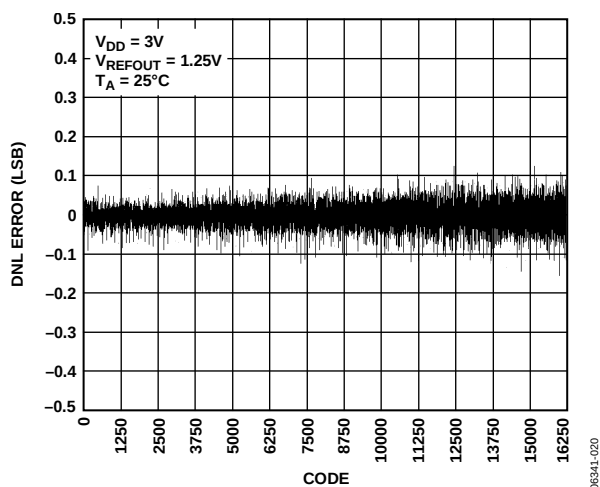


Figure 25. DNL, AD5645R, 1.25 V Internal Reference

06341-020

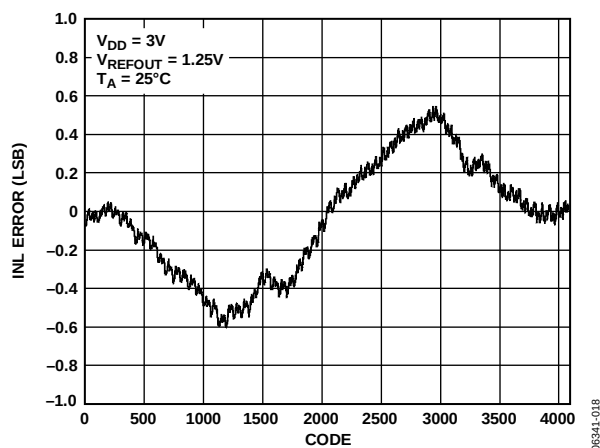


Figure 23. INL, AD5625R, 1.25 V Internal Reference

06341-018

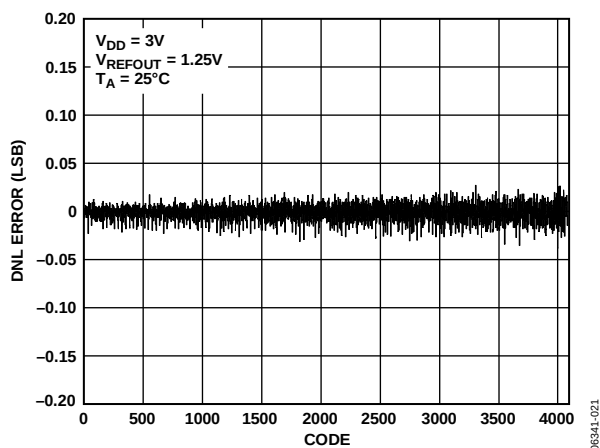


Figure 26. DNL, AD5625R, 1.25 V Internal Reference

06341-021

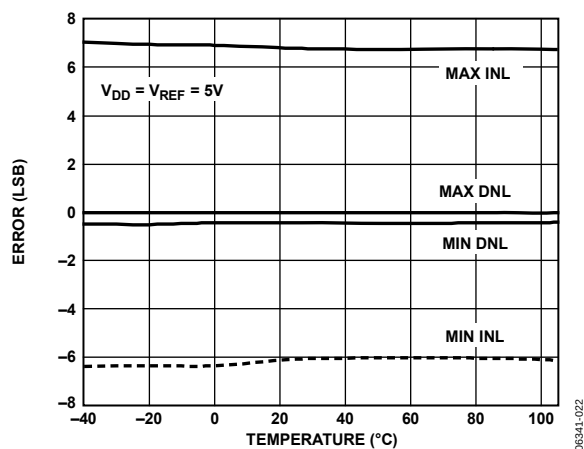


Figure 27. INL Error and DNL Error vs. Temperature

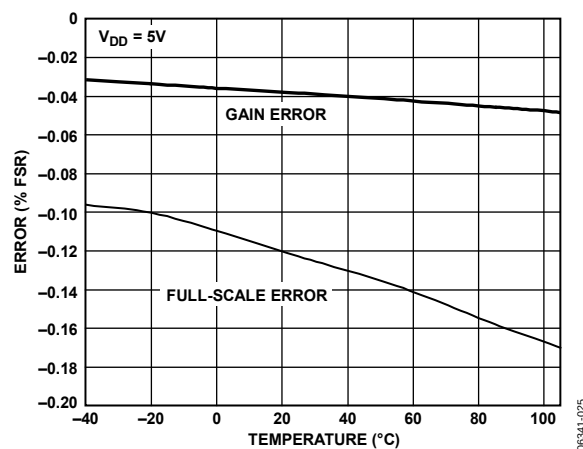


Figure 30. Gain Error and Full-Scale Error vs. Temperature

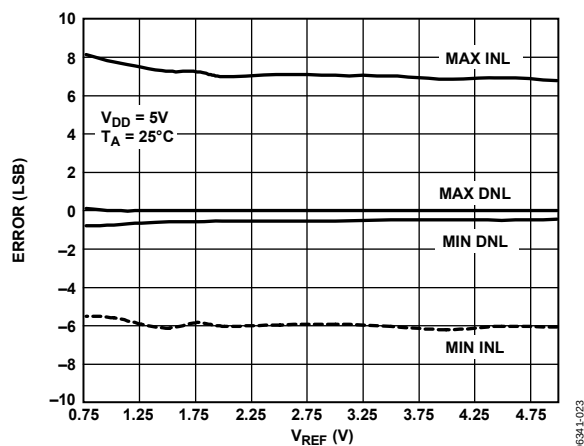
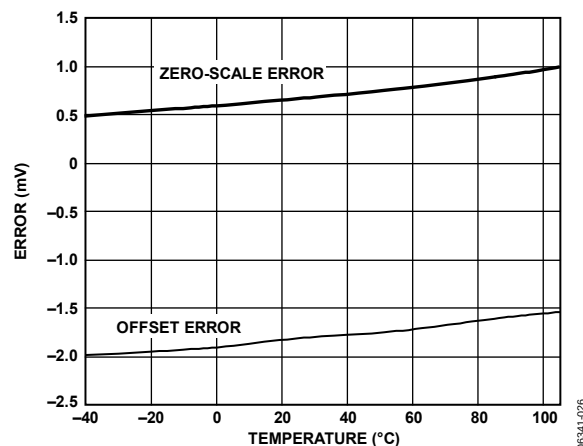
Figure 28. INL Error and DNL Error vs.  $V_{REF}$ 

Figure 31. Zero-Scale Error and Offset Error vs. Temperature

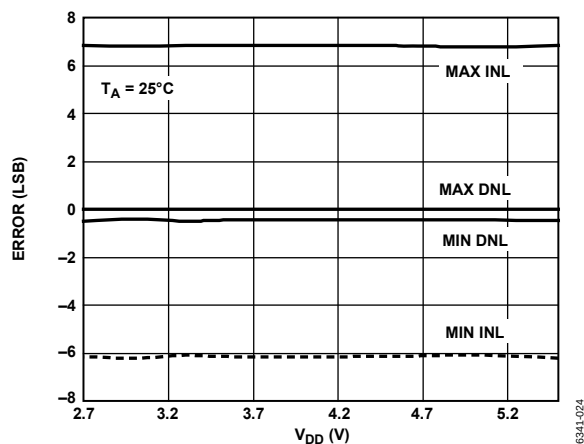


Figure 29. INL Error and DNL Error vs. Supply

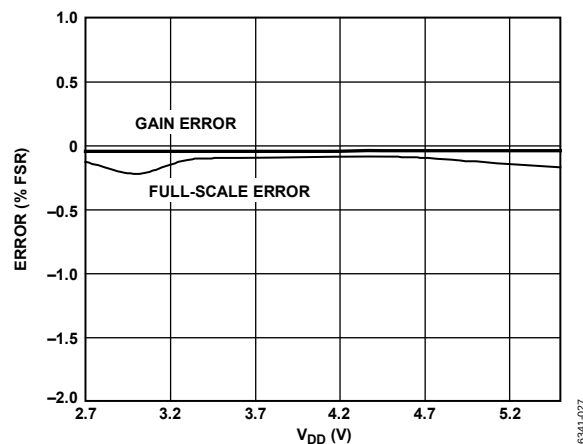


Figure 32. Gain Error and Full-Scale Error vs. Supply



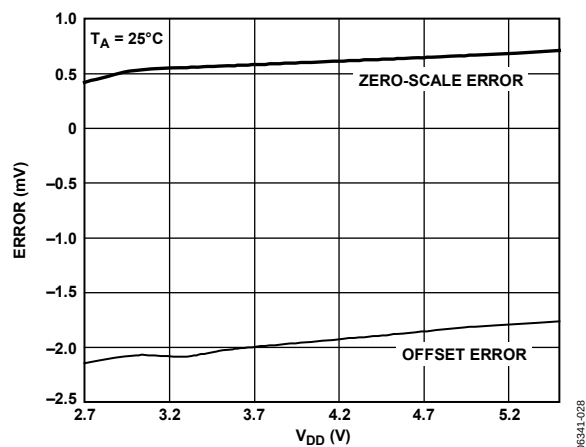


Figure 33. Zero-Scale Error and Offset Error vs. Supply

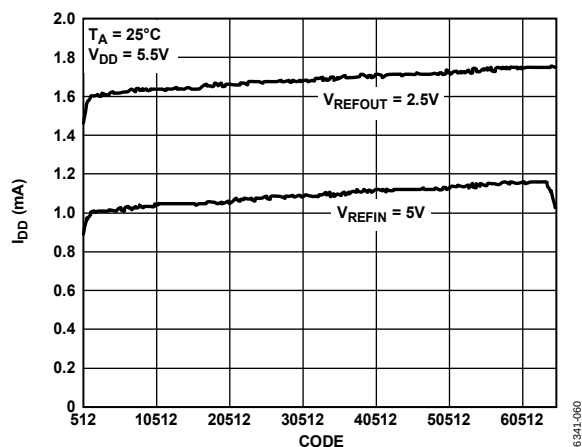


Figure 36. Supply Current vs. DAC Code

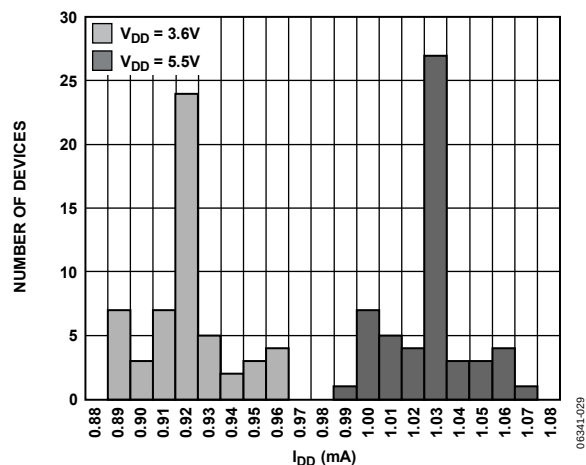
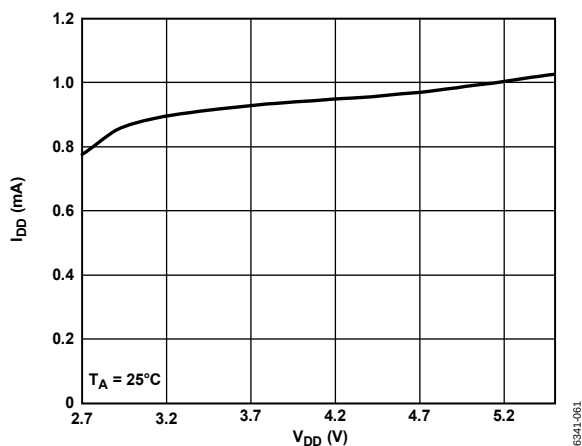
Figure 34.  $I_{DD}$  Histogram with External Reference

Figure 37. Supply Current vs. Supply

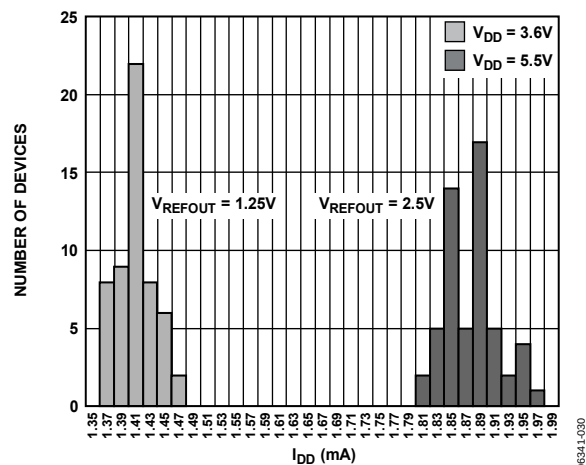
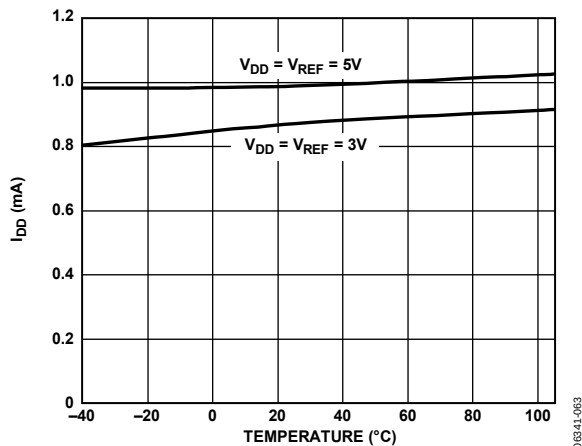
Figure 35.  $I_{DD}$  Histogram with Internal Reference

Figure 38. Supply Current vs. Temperature

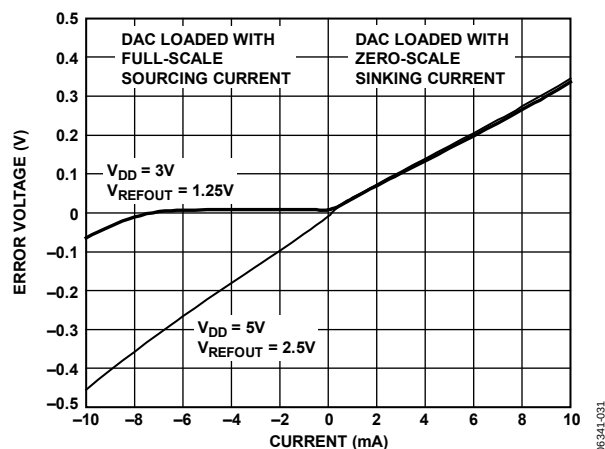


Figure 39. Headroom at Rails vs. Source and Sink

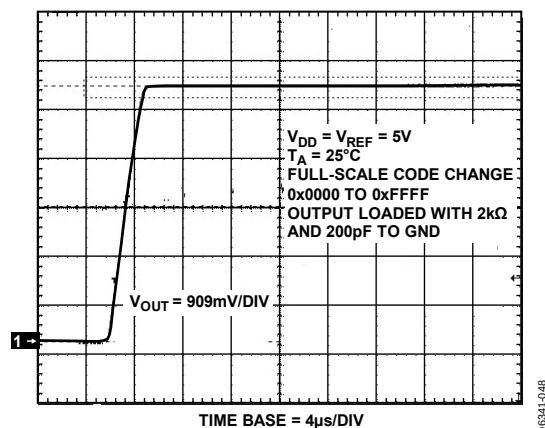


Figure 42. Full-Scale Settling Time, 5 V

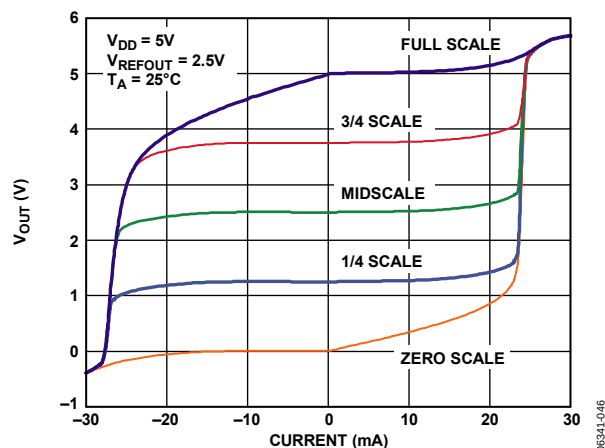


Figure 40. AD5625R/AD5645R/AD5665R with 2.5 V Reference, Source and Sink Capability

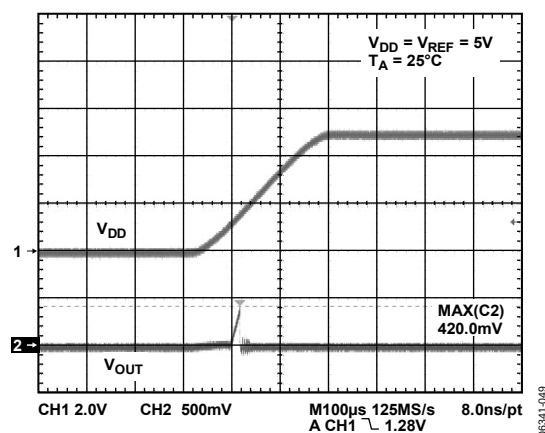


Figure 43. Power-On Reset to 0 V

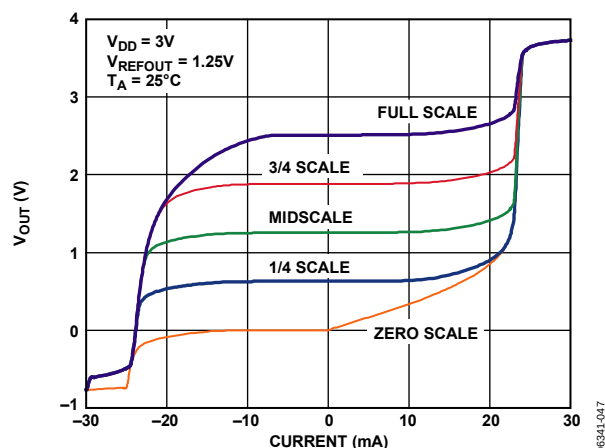


Figure 41. AD5625R/AD5645R/AD5665R with 1.25 V Reference, Source and Sink Capability

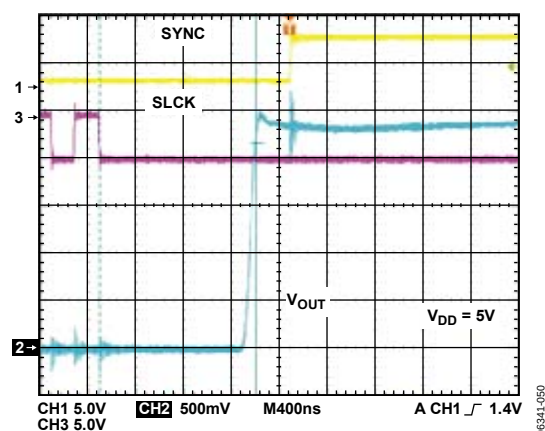


Figure 44. Exiting Power-Down to Midscale

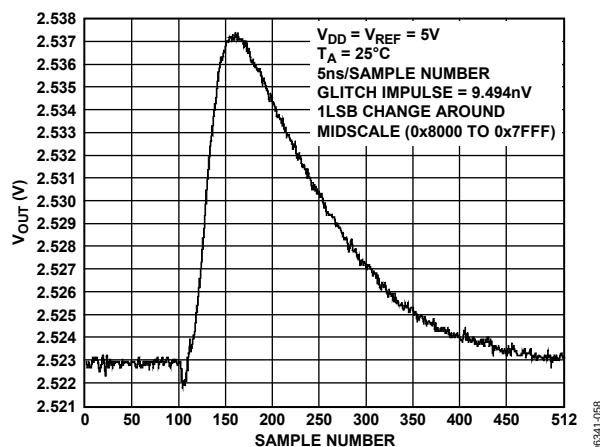


Figure 45. Digital-to-Analog Glitch Impulse (Negative)

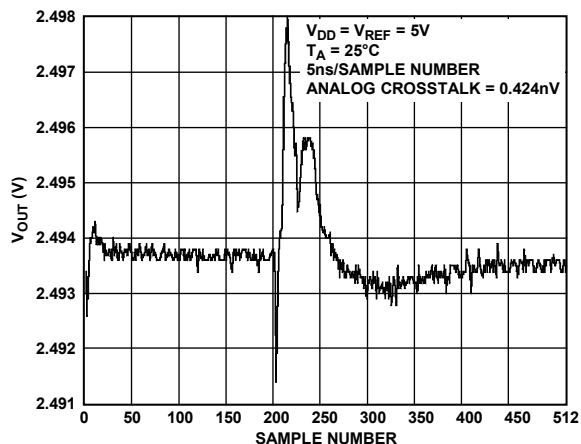


Figure 46. Analog Crosstalk, External Reference

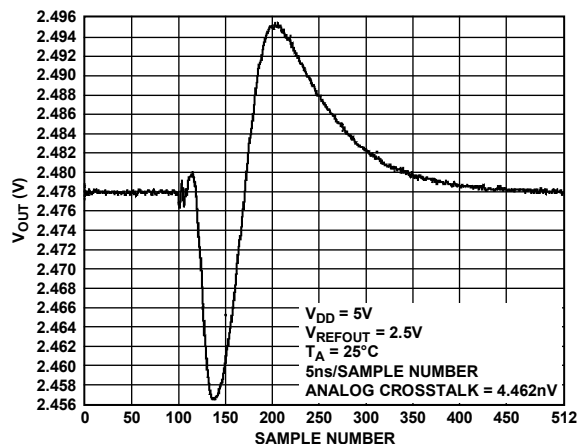


Figure 47. Analog Crosstalk, Internal Reference

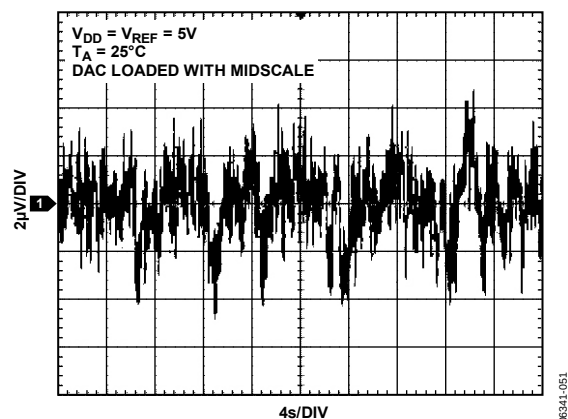


Figure 48. 0.1 Hz to 10 Hz Output Noise Plot, External Reference

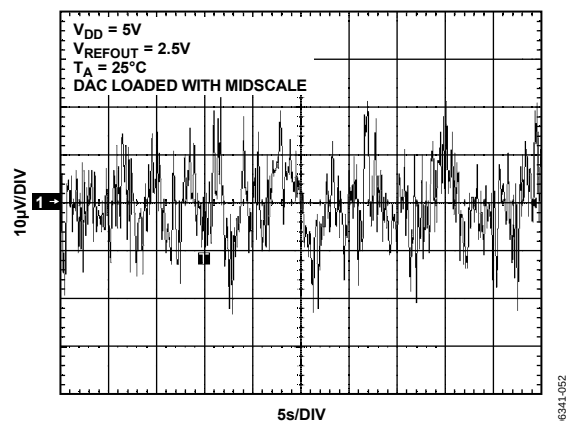


Figure 49. 0.1 Hz to 10 Hz Output Noise Plot, 2.5 V Internal Reference

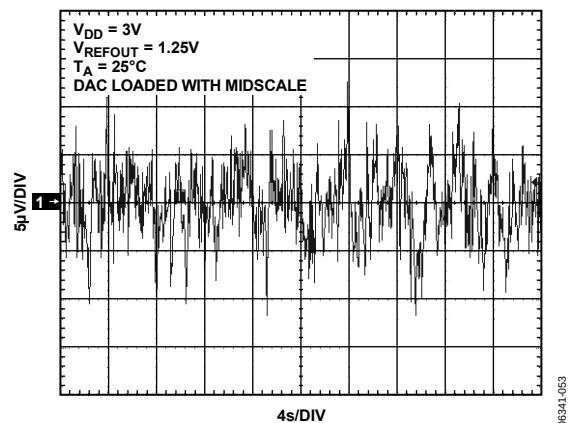


Figure 50. 0.1 Hz to 10 Hz Output Noise Plot, 1.25 V Internal Reference

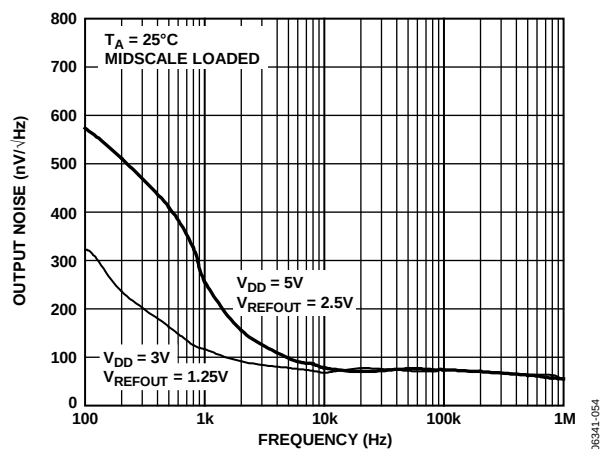


Figure 51. Noise Spectral Density, Internal Reference

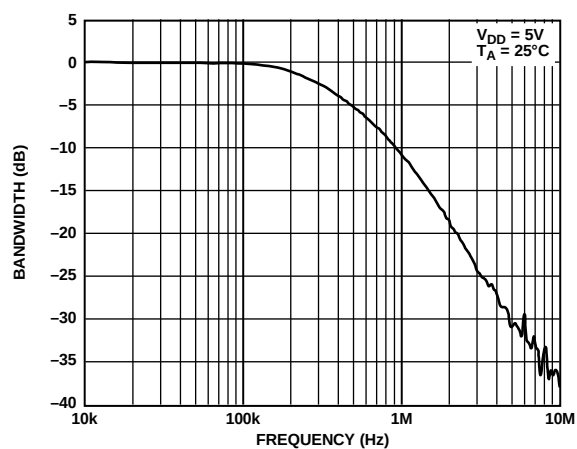


Figure 54. Multiplying Bandwidth

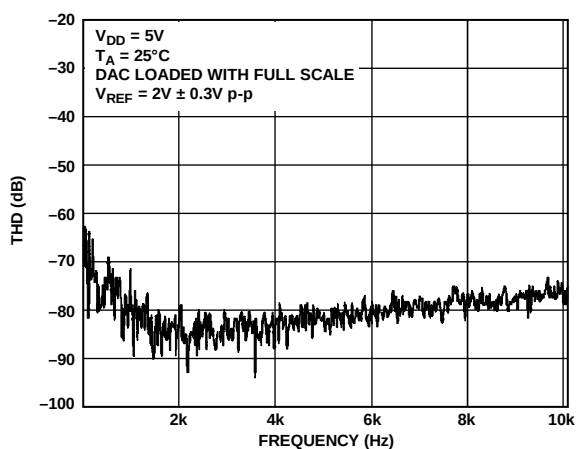


Figure 52. Total Harmonic Distortion

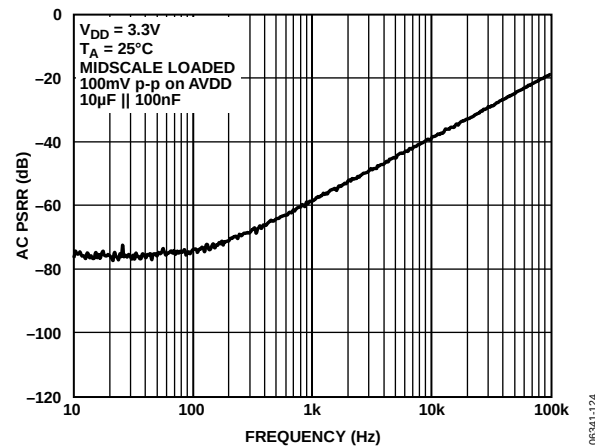


Figure 55. AC Power Supply Rejection Ratio (AC PSRR) vs. Frequency

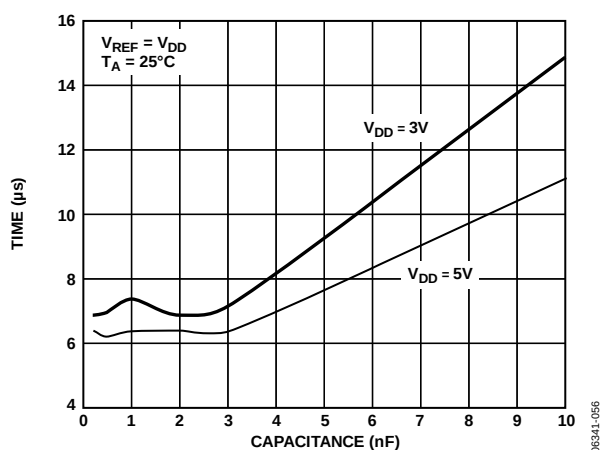


Figure 53. Settling Time vs. Capacitive Load

## TERMINOLOGY

### Relative Accuracy or Integral Nonlinearity (INL)

For the DAC, relative accuracy or integral nonlinearity is a measurement of the maximum deviation, in LSBs, from a straight line passing through the endpoints of the DAC transfer function.

### Differential Nonlinearity (DNL)

Differential nonlinearity is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of  $\pm 1$  LSB maximum ensures monotonicity. This DAC is guaranteed monotonic by design.

### Zero-Code Error

Zero-code error is a measurement of the output error when zero scale (0x0000) is loaded to the DAC register. Ideally, the output should be 0 V. The zero-code error is always positive in the AD5665R because the output of the DAC cannot go below 0 V due to a combination of the offset errors in the DAC and the output amplifier. Zero-code error is expressed in millivolts (mV).

### Full-Scale Error

Full-scale error is a measurement of the output error when full-scale code (0xFFFF) is loaded to the DAC register. Ideally, the output should be  $V_{DD} - 1$  LSB. Full-scale error is expressed as a percentage of full-scale range (FSR).

### Gain Error

Gain error is a measure of the span error of the DAC. It is the deviation in slope of the DAC transfer characteristic from ideal expressed as a percentage of full-scale range (FSR).

### Zero-Code Error Drift

Zero-code error drift is a measurement of the change in zero-code error with a change in temperature. It is expressed in microvolts per degrees Celsius ( $\mu\text{V}/^\circ\text{C}$ ).

### Gain Temperature Coefficient

Gain temperature coefficient is a measurement of the change in gain error with changes in temperature. It is expressed in parts per million (ppm) of full-scale range per degrees Celsius (FSR/ $^\circ\text{C}$ ).

### Offset Error

Offset error is a measure of the difference between  $V_{OUT}$  (actual) and  $V_{OUT}$  (ideal) expressed in mV in the linear region of the transfer function. Offset error is measured on the AD5665R with Code 512 loaded in the DAC register. It can be negative or positive.

### DC Power Supply Rejection Ratio (PSRR)

DC PSRR indicates how the output of the DAC is affected by changes in the supply voltage. PSRR is the ratio of the change in  $V_{OUT}$  to the change in  $V_{DD}$  for full-scale output of the DAC. It is measured in decibels (dB).  $V_{REF}$  is held at 2 V, and  $V_{DD}$  is varied by  $\pm 10\%$ .

### Output Voltage Settling Time

Output voltage settling time is the amount of time it takes for the output of a DAC to settle to a specified level for a  $\frac{1}{4}$  to  $\frac{3}{4}$  full-scale input change, and it is measured from the rising edge of the stop condition.

### Digital-to-Analog Glitch Impulse

Digital-to-analog glitch impulse is the impulse injected into the analog output when the input code in the DAC register changes state. It is normally specified as the area of the glitch in nV-s and is measured when the digital input code is changed by 1 LSB at the major carry transition (0x7FFF to 0x8000) (see Figure 45).

### Digital Feedthrough

Digital feedthrough is a measure of the impulse injected into the analog output of the DAC from the digital inputs of the DAC but is measured when the DAC output is not updated. It is specified in nV-s and is measured with a full-scale code change on the data bus, that is, from all 0s to all 1s and vice versa.

### Reference Feedthrough

Reference feedthrough is the ratio of the amplitude of the signal at the DAC output to the reference input when the DAC output is not being updated. It is expressed in decibels (dB).

### Output Noise Spectral Density

Output noise spectral density is a measurement of the internally generated random noise, which is characterized as a spectral density (nanovolts per square root of hertz frequency ( $\text{nV}/\sqrt{\text{Hz}}$ )). It is measured by loading the DAC to midscale and measuring noise at the output. It is measured in nanovolts per square root of hertz frequency ( $\text{nV}/\sqrt{\text{Hz}}$ ). A plot of noise spectral density is shown in Figure 51.

### DC Crosstalk

DC crosstalk is the dc change in the output level of one DAC in response to a change in the output of another DAC. It is measured with a full-scale output change on one DAC (or soft power-down and power-up) while monitoring another DAC kept at midscale. It is expressed in microvolts ( $\mu\text{V}$ ).

DC crosstalk due to load current change is a measure of the impact that a change in load current on one DAC has on another DAC kept at midscale. It is expressed in microvolts per milliampere ( $\mu\text{V}/\text{mA}$ ).

### Digital Crosstalk

This is the glitch impulse transferred to the output of one DAC at midscale in response to a full-scale code change (all 0s to all 1s and vice versa) in the input register of another DAC. It is measured in standalone mode and is expressed in nanovolts per second (nV-s).

**Analog Crosstalk**

Analog crosstalk is the glitch impulse transferred to the output of one DAC due to a change in the output of another DAC. It is measured by loading one of the input registers with a full-scale code change (all 0s to all 1s and vice versa) and then executing a software LDAC and monitoring the output of the DAC whose digital code was not changed. The area of the glitch is expressed in nanovolts per second (nV-s).

**DAC-to-DAC Crosstalk**

DAC-to-DAC crosstalk is the glitch impulse transferred to the output of one DAC due to a digital code change and subsequent analog output change of another DAC. It is measured by loading the attack channel with a full-scale code change (all 0s to all 1s and vice versa) with  $\overline{\text{LDAC}}$  low while monitoring the output of the victim channel that is at midscale. The energy of the glitch is expressed in nanovolts per second (nV-s).

**Multiplying Bandwidth**

The multiplying bandwidth is a measure of the finite bandwidth of the amplifiers within the DAC. A sine wave on the reference (with full-scale code loaded to the DAC) appears on the output. The multiplying bandwidth is the frequency at which the output amplitude falls to 3 dB below the input.

**Total Harmonic Distortion (THD)**

THD is the difference between an ideal sine wave and its attenuated version using the DAC. The sine wave is used as the reference for the DAC, and the THD is a measurement of the harmonics present on the DAC output. It is measured in decibels (dB).

**AC Power Supply Rejection Ratio (AC PSRR)**

AC PSRR is a measure of the rejection of the output voltage to ac changes in the power supplies applied to the DAC. It is measured for a given amplitude and frequency change in power supply voltage and is expressed in decibels.

## THEORY OF OPERATION

### DIGITAL-TO-ANALOG CONVERTER (DAC)

The AD5625R/AD5645R/AD5665R and AD5625/AD5665 DACs are fabricated on a CMOS process. The AD5625/AD5665 do not have an internal reference, and the DAC architecture is shown in Figure 56. The AD5625R/AD5645R/AD5665R do have an internal reference and can be configured for use with either an internal or external reference (see Figure 56 and Figure 57).

Because the input coding to the DAC is straight binary, the ideal output voltage when using an external reference is given by

$$V_{OUT} = V_{REFIN} \times \left( \frac{D}{2^N} \right)$$

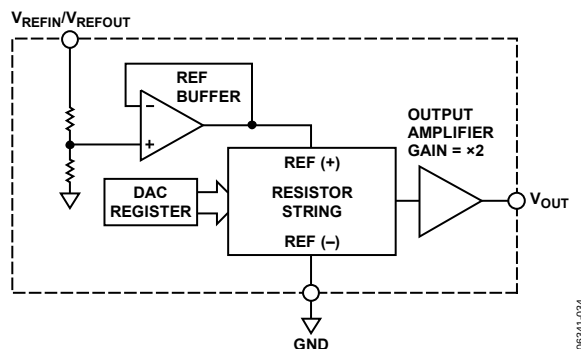


Figure 56. Internal Configuration When Using an External Reference

The ideal output voltage when using the internal reference is given by

$$V_{OUT} = 2 \times V_{REFOUT} \times \left( \frac{D}{2^N} \right)$$

where:

$D$  is the decimal equivalent of the binary code that is loaded to the DAC register, as follows:

- 0 to 4095 for AD5625R/AD5625 (12-bit).
- 0 to 16,383 for AD5645R (14-bit).
- 0 to 65,535 for AD5665R/AD5665 (16-bit).

$N$  is the DAC resolution.

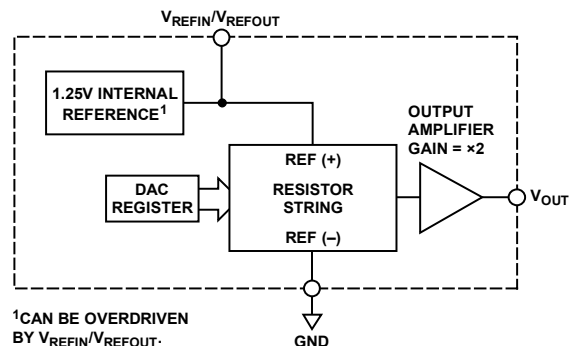


Figure 57. Internal Configuration When Using the Internal Reference

### RESISTOR STRING

The resistor string is shown in Figure 58. It is simply a string of resistors, each of value  $R$ . The code loaded to the DAC register determines at which node on the string the voltage is tapped off to be fed into the output amplifier. The voltage is tapped off by closing one of the switches connecting the string to the amplifier. Because it is a string of resistors, it is guaranteed monotonic.

### OUTPUT AMPLIFIER

The output buffer amplifier can generate rail-to-rail voltages on its output, which gives an output range of 0 V to  $V_{DD}$ . It can drive a load of 2 k $\Omega$  in parallel with 1000 pF to GND. The source and sink capabilities of the output amplifier are shown in Figure 39 and Figure 40. The slew rate is 1.8 V/ $\mu$ s with a 1/4 to 3/4 full-scale settling time of 7  $\mu$ s.

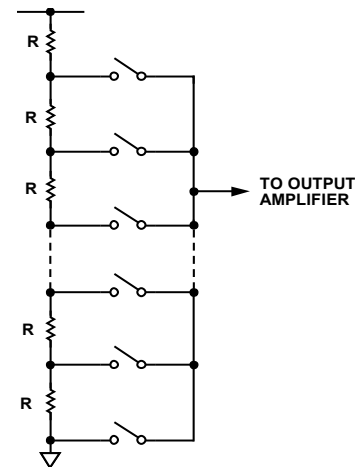


Figure 58. Resistor String

### INTERNAL REFERENCE

The AD5625R/AD5645R/AD5665R feature an on-chip reference. Versions without the R suffix require an external reference. The on-chip reference is off at power-up and is enabled via a write to a control register. See the Internal Reference Setup section for details.

Versions packaged in a 10-lead LFCSP have a 1.25 V reference or a 2.5 V reference, giving a full-scale output of 2.5 V or 5 V, depending on the model selected (see the Ordering Guide). The WLCSP has an internal reference of 1.25 V. These devices can be operated with a  $V_{DD}$  supply of 2.7 V to 5.5 V. Versions packaged in a 14-lead TSSOP have a 2.5 V reference, giving a full-scale output of 5 V. Devices are functional with a  $V_{DD}$  supply of 2.7 V to 5.5 V, but with a  $V_{DD}$  supply of less than 5 V, the output is clamped to  $V_{DD}$ . See the Ordering Guide for a full list of models. The internal reference associated with each device is available at the  $V_{REFOUT}$  pin (available on R suffix versions only).

A buffer is required if the reference output is used to drive external loads. When using the internal reference, it is recommended that a 100 nF capacitor be placed between the reference output and GND for reference stability.

## EXTERNAL REFERENCE

The  $V_{REFIN}$  pin on the [AD5625R/AD5645R/AD5665R](#) allows the use of an external reference if the application requires it. The default condition of the on-chip reference is off at power-up. All devices can be operated from a single 2.7 V to 5.5 V supply.

## SERIAL INTERFACE

The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) have 2-wire I<sup>2</sup>C-compatible serial interfaces. The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) can be connected to an I<sup>2</sup>C bus as a slave device, under the control of a master device. See Figure 3 for a timing diagram of a typical write sequence.

The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) support standard (100 kHz), fast (400 kHz), and high speed (3.4 MHz) data transfer modes. High speed operation is only available on selected models. See the Ordering Guide for a full list of models. Support is not provided for 10-bit addressing and general call addressing.

The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) each have a 7-bit slave address. The 10-lead and 12-ball versions of the device have a slave address whose five MSBs are 00011, and the two LSBs are set by the state of the ADDR address pin, which determines the state of the A0 and A1 address bits. The 14-lead versions of the device have a slave address whose three MSBs are 001, and the four LSBs are set by the ADDR1 and ADDR2 address pins, which determine the state of the A0 and A1 and A2 and A3 address bits, respectively.

The facility to make hardwired changes to the ADDR pin allows the user to incorporate up to three of these devices on one bus, as outlined in Table 9.

**Table 9. ADDR Pin Settings (10-Lead and 12-Ball Packages)**

| ADDR Pin Connection | A1 | A0 |
|---------------------|----|----|
| $V_{DD}$            | 0  | 0  |
| NC                  | 1  | 0  |
| GND                 | 1  | 1  |

The facility to make hardwired changes to the ADDR1 and the ADDR2 pins allows the user to incorporate up to nine of these devices on one bus, as outlined in Table 10.

**Table 10. ADDR1, ADDR2 Pin Settings (14-Lead Package)**

| ADDR2 Pin Connection | ADDR1 Pin Connection | A3 | A2 | A1 | A0 |
|----------------------|----------------------|----|----|----|----|
| $V_{DD}$             | $V_{DD}$             | 0  | 0  | 0  | 0  |
| $V_{DD}$             | NC                   | 0  | 0  | 1  | 0  |
| $V_{DD}$             | GND                  | 0  | 0  | 1  | 1  |
| NC                   | $V_{DD}$             | 1  | 0  | 0  | 0  |
| NC                   | NC                   | 1  | 0  | 1  | 0  |
| NC                   | GND                  | 1  | 0  | 1  | 1  |
| GND                  | $V_{DD}$             | 1  | 1  | 0  | 0  |
| GND                  | NC                   | 1  | 1  | 1  | 0  |
| GND                  | GND                  | 1  | 1  | 1  | 1  |

The 2-wire serial bus protocol operates as follows:

1. The master initiates data transfer by establishing a start condition when a high-to-low transition on the SDA line occurs while SCL is high. The following byte is the address byte, which consists of the 7-bit slave address. The slave address corresponding to the transmitted address responds by pulling SDA low during the ninth clock pulse (this is termed the acknowledge bit). At this stage, all other devices on the bus remain idle while the selected device waits for data to be written to or read from its shift register.
2. Data is transmitted over the serial bus in sequences of nine clock pulses (eight data bits followed by an acknowledge bit). The transitions on the SDA line must occur during the low period of SCL and remain stable during the high period of SCL.
3. When all data bits have been read or written, a stop condition is established. In write mode, the master pulls the SDA line high during the 10<sup>th</sup> clock pulse to establish a stop condition. If a stop condition is generated between the 7<sup>th</sup> and 8<sup>th</sup> clock pulse of the I<sup>2</sup>C address frame, a power cycle is required to recover the device. In read mode, the master issues a no acknowledge for the ninth clock pulse (that is, the SDA line remains high). The master brings the SDA line low before the 10<sup>th</sup> clock pulse, and then high during the 10<sup>th</sup> clock pulse to establish a stop condition.

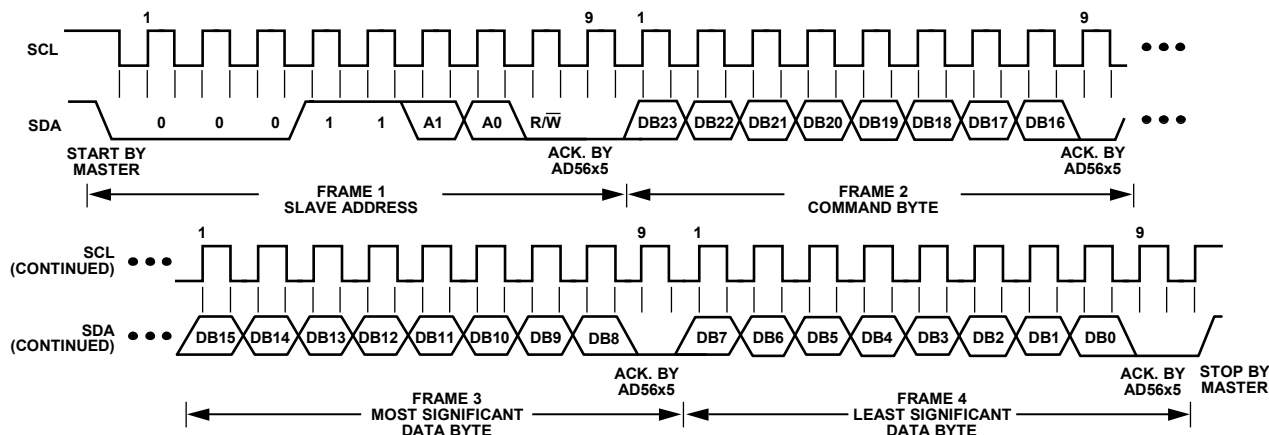
## WRITE OPERATION

When writing to the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#), the user must begin with a start command followed by an address byte ( $R/\overline{W} = 0$ ), after which the DAC acknowledges that it is prepared to receive data by pulling SDA low. The [AD5665](#) requires two bytes of data for the DAC and a command byte that controls various DAC functions. Three bytes of data must, therefore, be written to the DAC, the command byte followed by the most significant data byte and the least significant data byte, as shown in Figure 59 and Figure 60. After these data bytes are acknowledged by the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#), a stop condition follows.

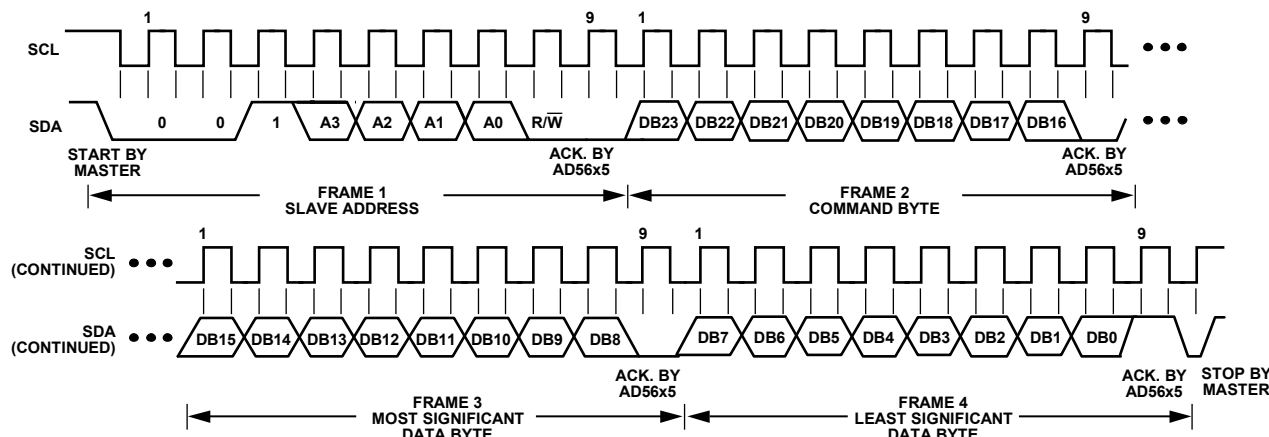
## READ OPERATION

When reading data back from the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#), the user begins with a start command followed by an address byte ( $R/\overline{W} = 1$ ), after which the DAC acknowledges that it is prepared to transmit data by pulling SDA low. Two bytes of data are then read from the DAC, which are both acknowledged by the master as shown in Figure 61 and Figure 62. A stop condition follows. When a read operation is performed, the DAC shifts out the last transferred command.

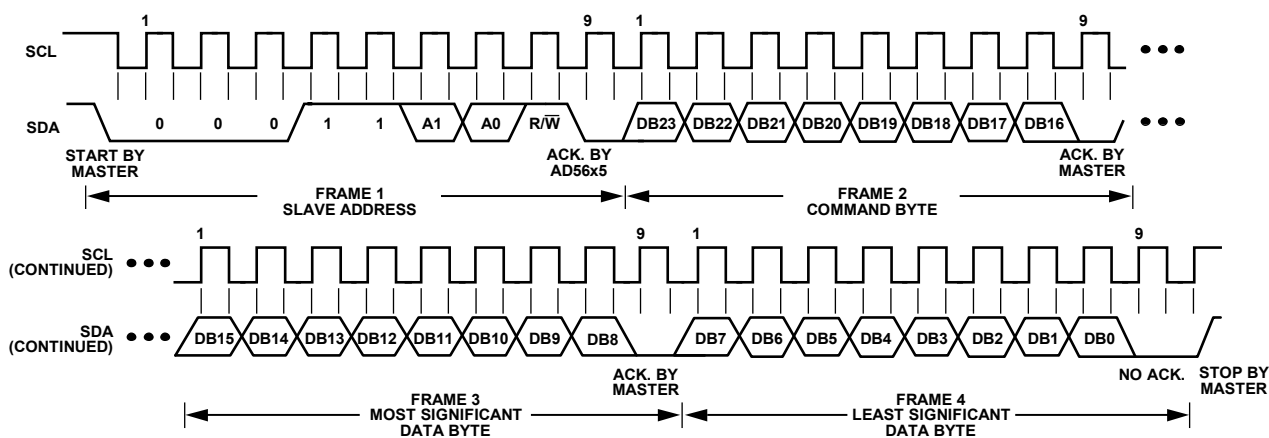




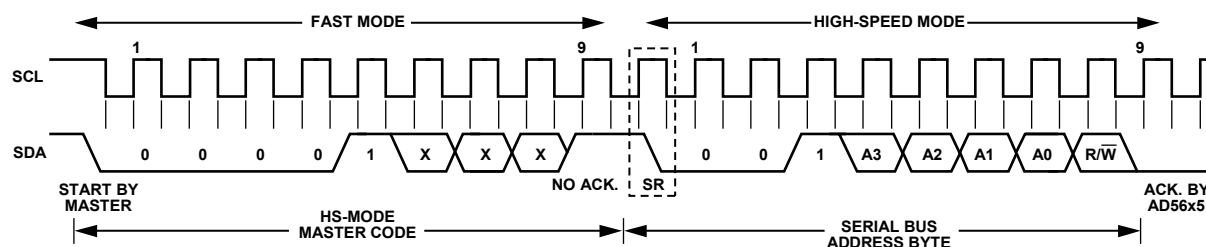
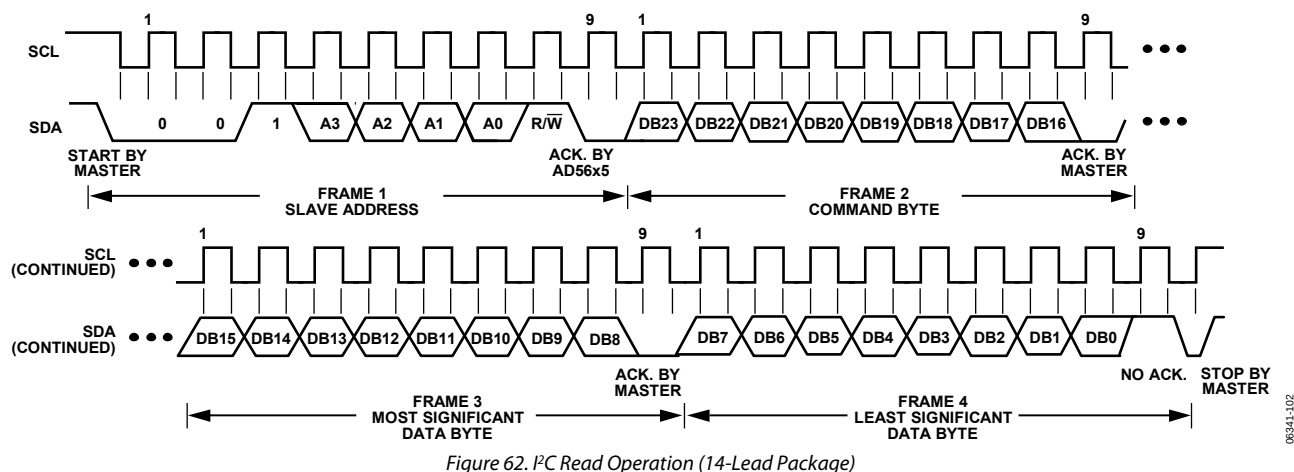
06341-103



06341-104



06341-101



## HIGH SPEED MODE

Some models offer high speed serial communication with a clock frequency of 3.4 MHz. See the Ordering Guide for a full list of models.

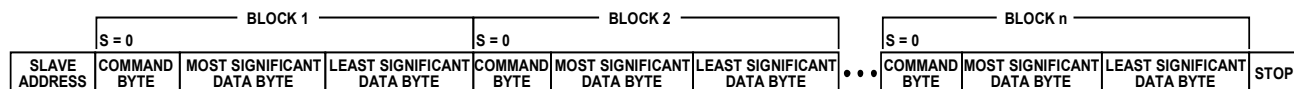
High speed mode communication commences after the master addresses all devices connected to the bus with the Master Code 00001XXX to indicate that a high speed mode transfer is to begin. No device connected to the bus is permitted to acknowledge the high speed master code; therefore, the code is followed by a no acknowledge. Next, the master must issue a repeated start followed by the device address. The selected device then acknowledges its address. All devices continue to operate in high speed mode until the master issues a stop condition. When the stop condition is issued, the devices return to standard/fast mode. The device also returns to standard/fast mode when  $\overline{\text{CLR}}$  is activated while the device is in high speed mode.

## INPUT SHIFT REGISTER

The input shift register is 24 bits wide. Data is loaded into the device as a 24-bit word under the control of a serial clock input, SCL. The timing diagram for this operation is shown in Figure 3. The eight MSBs make up the command byte. DB23 is reserved and should always be set to 0 when writing to the device. DB22 (S) is used to select multiple byte operation. The next three bits are the command bits (C2, C1, and C0) that control the mode of operation of the device. See Table 11 for details. The last three bits of the first byte are the address bits (A2, A1, and A0). See Table 12 for details. The rest of the bits are the 16-/14-/12-bit data-word. The data-word comprises the 16-/14-/12-bit input code followed by two or four don't care bits for the AD5645R and the AD5625R/AD5625, respectively (see Figure 66 through Figure 68).

## MULTIPLE BYTE OPERATION

Multiple byte operation is supported on the AD5625R/AD5645R/AD5665R and AD5625/AD5665. A 2-byte operation is useful for applications that require fast DAC updating and do not need to change the command byte. The S bit (DB22) in the command register can be set to 1 for 2-byte mode of operation (see Figure 65). For standard 3-byte and 4-byte operation, the S bit (DB22) in the command byte should be set to 0 (see Figure 64).

Figure 64. Multiple Block Write with Command Byte in Each Block ( $S = 0$ )Figure 65. Multiple Block Write with Initial Command Byte Only ( $S = 1$ )

| DB23     | DB22              | DB21         | DB20 | DB19 | DB18        | DB17           | DB16 | DB15     | DB14 | DB13 | DB12 | DB11 | DB10 | DB9           | DB8 | DB7      | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|----------|-------------------|--------------|------|------|-------------|----------------|------|----------|------|------|------|------|------|---------------|-----|----------|-----|-----|-----|-----|-----|-----|-----|
| R        | S                 | C2           | C1   | C0   | A2          | A1             | A0   | D15      | D14  | D13  | D12  | D11  | D10  | D9            | D8  | D7       | D6  | D5  | D4  | D3  | D2  | D1  | D0  |
| RESERVED | BYTE<br>SELECTION | COMMAND      |      |      | DAC ADDRESS |                |      | DAC DATA |      |      |      |      |      |               |     | DAC DATA |     |     |     |     |     |     |     |
|          |                   | COMMAND BYTE |      |      |             | DATA HIGH BYTE |      |          |      |      |      |      |      | DATA LOW BYTE |     |          |     |     |     |     |     |     |     |

Figure 66. [AD5665R/AD5665](#) Input Shift Register (16-Bit DAC)

| DB23     | DB22              | DB21         | DB20 | DB19 | DB18        | DB17 | DB16 | DB15     | DB14           | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7      | DB6           | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|----------|-------------------|--------------|------|------|-------------|------|------|----------|----------------|------|------|------|------|-----|-----|----------|---------------|-----|-----|-----|-----|-----|-----|
| R        | S                 | C2           | C1   | C0   | A2          | A1   | A0   | D13      | D12            | D11  | D10  | D9   | D8   | D7  | D6  | D5       | D4            | D3  | D2  | D1  | D0  | X   | X   |
| RESERVED | BYTE<br>SELECTION | COMMAND      |      |      | DAC ADDRESS |      |      | DAC DATA |                |      |      |      |      |     |     | DAC DATA |               |     |     |     |     |     |     |
|          |                   | COMMAND BYTE |      |      |             |      |      |          | DATA HIGH BYTE |      |      |      |      |     |     |          | DATA LOW BYTE |     |     |     |     |     |     |

Figure 67. [AD5645R](#) Input Shift Register (14-Bit DAC)

| DB23     | DB22           | DB21         | DB20 | DB19 | DB18        | DB17           | DB16 | DB15     | DB14 | DB13 | DB12 | DB11 | DB10 | DB9           | DB8 | DB7      | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0 |
|----------|----------------|--------------|------|------|-------------|----------------|------|----------|------|------|------|------|------|---------------|-----|----------|-----|-----|-----|-----|-----|-----|-----|
| R        | S              | C2           | C1   | C0   | A2          | A1             | A0   | D11      | D10  | D9   | D8   | D7   | D6   | D5            | D4  | D3       | D2  | D1  | D0  | X   | X   | X   | X   |
| RESERVED | BYTE SELECTION | COMMAND      |      |      | DAC ADDRESS |                |      | DAC DATA |      |      |      |      |      |               |     | DAC DATA |     |     |     |     |     |     |     |
|          |                | COMMAND BYTE |      |      |             | DATA HIGH BYTE |      |          |      |      |      |      |      | DATA LOW BYTE |     |          |     |     |     |     |     |     |     |

Figure 68. [AD5625R/AD5625](#) Input Shift Register (12-Bit DAC)

**BROADCAST MODE**

Broadcast addressing is supported on the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) in write mode only. Broadcast addressing can be used to synchronously update or power down multiple [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) devices. When the broadcast address is used, the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) respond regardless of the states of the address pins. The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) broadcast address is 00010000.

**Table 11. Command Definition**

| C2 | C1 | C0 | Command                                               |
|----|----|----|-------------------------------------------------------|
| 0  | 0  | 0  | Write to input Register n                             |
| 0  | 0  | 1  | Update DAC Register n                                 |
| 0  | 1  | 0  | Write to input Register n, update all (software LDAC) |
| 0  | 1  | 1  | Write to and update DAC Channel n                     |
| 1  | 0  | 0  | Power up/power down                                   |
| 1  | 0  | 1  | Reset                                                 |
| 1  | 1  | 0  | LDAC register setup                                   |
| 1  | 1  | 1  | Internal reference setup (on/off)                     |

**Table 12. DAC Address Command**

| A2 | A1 | A0 | ADDRESS (n) |
|----|----|----|-------------|
| 0  | 0  | 0  | DAC A       |
| 0  | 0  | 1  | DAC B       |
| 0  | 1  | 0  | DAC C       |
| 0  | 1  | 1  | DAC D       |
| 1  | 1  | 1  | All DACs    |

**LDAC FUNCTION**

The [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#) DACs have double-buffered interfaces consisting of two banks of registers: input registers and DAC registers. The input registers are connected directly to the input shift register, and the digital code is transferred to the relevant input register upon completion of a valid write sequence. The DAC registers contain the digital code used by the resistor strings.

Access to the DAC registers is controlled by the  $\overline{\text{LDAC}}$  pin. When the  $\overline{\text{LDAC}}$  pin is high, the DAC registers are latched and the input registers can change state without affecting the contents of the DAC registers. When  $\overline{\text{LDAC}}$  is brought low, however, the DAC registers become transparent and the contents of the input registers are transferred to them. The double-buffered interface is useful if the user requires simultaneous updating of all DAC outputs. The user can write to one of the input registers individually and then, by bringing  $\overline{\text{LDAC}}$  low when writing to the other DAC input register, all outputs update simultaneously.

These devices each contain an extra feature whereby a DAC register is not updated unless its input register has been updated since the last time  $\overline{\text{LDAC}}$  was brought low. Normally, when  $\overline{\text{LDAC}}$  is brought low, the DAC registers are filled with the contents of the input registers. In the case of the [AD5625R/AD5645R/AD5665R](#) and [AD5625/AD5665](#), the DAC register updates only if the input register has changed since the last time the DAC register was updated, thereby removing unnecessary digital crosstalk.

The outputs of all DACs can be simultaneously updated, using the hardware  $\overline{\text{LDAC}}$  pin.

**Synchronous  $\overline{\text{LDAC}}$** 

The DAC registers are updated after new data is read in.  $\overline{\text{LDAC}}$  can be permanently low or pulsed.

**Asynchronous  $\overline{\text{LDAC}}$** 

The outputs are not updated at the same time that the input registers are written to. When  $\overline{\text{LDAC}}$  goes low, the DAC registers are updated with the contents of the input register.

The  $\overline{\text{LDAC}}$  register gives the user full flexibility and control over the hardware  $\overline{\text{LDAC}}$  pin (and software  $\overline{\text{LDAC}}$  on the 10-lead devices that do not have the hardware  $\overline{\text{LDAC}}$  pin—see Table 13). This register allows the user to select which combination of channels to simultaneously update when the hardware  $\overline{\text{LDAC}}$  pin is executed. Setting the  $\overline{\text{LDAC}}$  bit register to 0 for a DAC channel means that the update of this channel is controlled by

the  $\overline{\text{LDAC}}$  pin. If this bit is set to 1, this channel synchronously updates; that is, the DAC register is updated after new data is read in, regardless of the state of the  $\overline{\text{LDAC}}$  pin. The device effectively sees the  $\overline{\text{LDAC}}$  pin as being pulled low. See Table 14 for the  $\overline{\text{LDAC}}$  register mode of operation. This flexibility is useful in applications when the user wants to simultaneously update select channels while the rest of the channels are synchronously updating.

Writing to the DAC using Command 110 loads the 4-bit  $\overline{\text{LDAC}}$  register [DB3:DB0]. The default for each channel is 0; that is, the  $\overline{\text{LDAC}}$  pin works normally. Setting the bits to 1 means that the DAC register is updated, regardless of the state of the  $\overline{\text{LDAC}}$  pin. See Figure 69 for the contents of the input shift register during the  $\overline{\text{LDAC}}$  register setup command.

**Table 13.  $\overline{\text{LDAC}}$  Register Mode of Operation on the 10-Lead LFCSP (Load DAC Register)**

| LDAC Bits (DB3 to DB0) | LDAC Mode of Operation                                                              |
|------------------------|-------------------------------------------------------------------------------------|
| 0                      | Normal operation (default), DAC register update is controlled by the write command. |
| 1                      | The DAC registers are updated after new data is read in.                            |

**Table 14.  $\overline{\text{LDAC}}$  Register Mode of Operation on the 14-Lead TSSOP (Load DAC Register)**

| LDAC Bits (DB3 to DB0) | LDAC Pin       | LDAC Operation                                           |
|------------------------|----------------|----------------------------------------------------------|
| 0                      | 1/0            | Determined by the $\overline{\text{LDAC}}$ pin.          |
| 1                      | X = don't care | The DAC registers are updated after new data is read in. |

| R        | S          | C2      | C1 | C0 | A2                       | A1 | A0 | DB15       | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7        | DB6 | DB5 | DB4 | DB3                                                      | DB2   | DB1   | DB0   |
|----------|------------|---------|----|----|--------------------------|----|----|------------|------|------|------|------|------|-----|-----|------------|-----|-----|-----|----------------------------------------------------------|-------|-------|-------|
| 0        | X          | 1       | 1  | 0  | A2                       | A1 | A0 | X          | X    | X    | X    | X    | X    | X   | X   | X          | X   | X   | X   | DAC D                                                    | DAC C | DAC B | DAC A |
| RESERVED | DON'T CARE | COMMAND |    |    | DAC ADDRESS (DON'T CARE) |    |    | DON'T CARE |      |      |      |      |      |     |     | DON'T CARE |     |     |     | DAC SELECT<br>(0 = $\overline{\text{LDAC}}$ PIN ENABLED) |       |       |       |

Figure 69.  $\overline{\text{LDAC}}$  Setup Command

06340-115

## POWER-DOWN MODES

Command 100 is reserved for the power-up/power-down function. The power-up/power-down modes are programmed by setting Bit DB5 and Bit DB4. This defines the output state of the DAC amplifier, as shown in Table 15. Bit DB3 to Bit DB0 determine to which DAC or DACs the power-up/power-down command is applied. Setting one of these bits to 1 applies the power-up/power-down state defined by DB5 and DB4 to the corresponding DAC. If a bit is 0, the state of the DAC is unchanged. Figure 71 shows the contents of the input shift register for the power-up/power-down command.

When Bit DB5 and Bit DB4 are set to 0, the device works normally with its normal power consumption of 1 mA at 5 V. However, for the three power-down modes, the supply current falls to 480 nA at 5 V. Not only does the supply current fall, but the output stage is also internally switched from the output of the amplifier to a resistor network of known values. This allows the output impedance of the device to be known while the device is in power-down mode. The outputs can either be connected internally to GND through a 1 k $\Omega$  or 100 k $\Omega$  resistor or be left open-circuited (three-state) as shown in Figure 68.

Note that the 14-lead TSSOP models offer the power-down function when the device is operated with a  $V_{DD}$  of 3.6 V to 5.5 V. The 10-lead LFCSP models offer the power-down function when the device is powered with a  $V_{DD}$  of 2.7 V to 5.5 V.

Table 15. Modes of Operation for the AD5625R/AD5645R/AD5665R and AD5625/AD5665

| DB5 | DB4 | Operating Mode                           |
|-----|-----|------------------------------------------|
| 0   | 0   | Normal operation                         |
|     |     | Power-down modes                         |
| 0   | 1   | 1 k $\Omega$ pull-down resistor to GND   |
| 1   | 0   | 100 k $\Omega$ pull-down resistor to GND |
| 1   | 1   | Three-state, high impedance              |

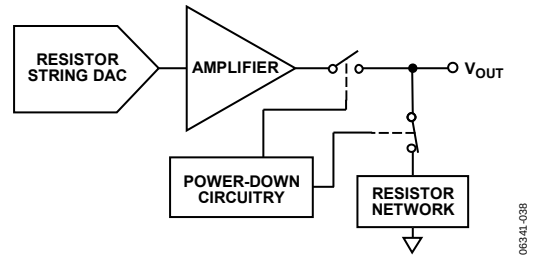


Figure 70. Output Stage During Power-Down

The bias generator, output amplifier, resistor string, and other associated linear circuitry are shut down when power-down mode is activated. However, the contents of the DAC register are unaffected when in power-down. The time to exit power-down is typically 4  $\mu$ s for  $V_{DD} = 5$  V or  $V_{DD} = 3$  V.

| R        | S          | C2      | C1 | C0 | A2                       | A1 | A0 | DB15       | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7        | DB6 | DB5             | DB4 | DB3                           | DB2   | DB1   | DB0   |
|----------|------------|---------|----|----|--------------------------|----|----|------------|------|------|------|------|------|-----|-----|------------|-----|-----------------|-----|-------------------------------|-------|-------|-------|
| 0        | X          | 1       | 0  | 0  | A2                       | A1 | A0 | X          | X    | X    | X    | X    | X    | X   | X   | X          | X   | PD1             | PD0 | DAC D                         | DAC C | DAC B | DAC A |
| RESERVED | DON'T CARE | COMMAND |    |    | DAC ADDRESS (DON'T CARE) |    |    | DON'T CARE |      |      |      |      |      |     |     | DON'T CARE |     | POWER-DOWN MODE |     | DAC SELECT (1 = DAC SELECTED) |       |       |       |

Figure 71. Power-Up/Power-Down Command

## POWER-ON RESET AND SOFTWARE RESET

The AD5625R/AD5645R/AD5665R and AD5625/AD5665 contain a power-on reset circuit that controls the output voltage during power-up. The 10-lead version of the device powers up to 0 V. The 14-lead version has a power-on reset (POR) pin that allows the output voltage to be selected. By connecting the POR pin to GND, the AD5625R/AD5645R/AD5665R and AD5625/AD5665 output powers up to 0 V; by connecting the POR pin to  $V_{DD}$ , the AD5625R/AD5645R/AD5665R and AD5625/AD5665 output powers up to midscale. The output remains powered up at this level until a valid write sequence is made to the DAC. This is useful in applications where it is important to know the state of the output of the DAC while it is in the process of powering up. Any events on  $\overline{\text{LDAC}}$  or  $\overline{\text{CLR}}$  during power-on reset are ignored.

There is also a software reset function. Command 101 is the software reset command. The software reset command contains two reset modes that are software programmable by setting bit DB0 in the input shift register.

Table 16 shows how the state of the bit corresponds to the software reset modes of operation of the devices. Figure 72 shows the contents of the input shift register during the software reset mode of operation.

Table 16. Software Reset Modes for the AD5625R/AD5645R/AD5665R and AD5625/AD5665

| DB0                | Registers Reset to Zero                                                                                                               |
|--------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| 0                  | DAC register<br>Input shift register                                                                                                  |
| 1 (Power-On Reset) | DAC register<br>Input shift register<br>$\overline{\text{LDAC}}$ register<br>Power-down register<br>Internal reference setup register |

## INTERNAL REFERENCE SETUP (R VERSIONS)

The on-chip reference is off at power-up by default. It can be turned on by sending the reference setup command (111) and setting DB0 in the input shift register. Table 17 shows how the state of the bit corresponds to the mode of operation.

Table 17. Reference Setup Command

| DB0 | Action                           |
|-----|----------------------------------|
| 0   | Internal reference off (default) |
| 1   | Internal reference on            |

| X        | S          | C2      | C1 | C0 | A2                       | A1 | A0 | DB15       | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7        | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0        |
|----------|------------|---------|----|----|--------------------------|----|----|------------|------|------|------|------|------|-----|-----|------------|-----|-----|-----|-----|-----|-----|------------|
| 0        | X          | 1       | 0  | 1  | X                        | X  | X  | X          | X    | X    | X    | X    | X    | X   | X   | X          | X   | X   | X   | X   | X   | X   | RST        |
| RESERVED | DON'T CARE | COMMAND |    |    | DAC ADDRESS (DON'T CARE) |    |    | DON'T CARE |      |      |      |      |      |     |     | DON'T CARE |     |     |     |     |     |     | RESET MODE |

06341-113

Figure 72. Reset Command

| R        | S          | C2      | C1 | C0 | A2                       | A1 | A0 | DB15       | DB14 | DB13 | DB12 | DB11 | DB10 | DB9 | DB8 | DB7        | DB6 | DB5 | DB4 | DB3 | DB2 | DB1 | DB0            |
|----------|------------|---------|----|----|--------------------------|----|----|------------|------|------|------|------|------|-----|-----|------------|-----|-----|-----|-----|-----|-----|----------------|
| 0        | X          | 1       | 1  | 1  | X                        | X  | X  | X          | X    | X    | X    | X    | X    | X   | X   | X          | X   | X   | X   | X   | X   | X   | REF            |
| RESERVED | DON'T CARE | COMMAND |    |    | DAC ADDRESS (DON'T CARE) |    |    | DON'T CARE |      |      |      |      |      |     |     | DON'T CARE |     |     |     |     |     |     | REFERENCE MODE |

06341-114

Figure 73. Reference Setup Command

## APPLICATIONS INFORMATION

### USING A REFERENCE AS A POWER SUPPLY FOR THE AD5625R/AD5645R/AD5665R AND AD5625/AD5665

Because the supply current required by the AD5625R/AD5645R/AD5665R and AD5625/AD5665 is extremely low, an alternative option is to use a voltage reference to supply the required voltage to the device (see Figure 74). This is especially useful if the power supply is noisy or if the system supply voltages are at some value other than 5 V or 3 V, for example, 15 V. The voltage reference outputs a steady supply voltage for the AD5625R/AD5645R/AD5665R and AD5625/AD5665. If the low dropout REF195 is used, it must supply 450  $\mu$ A of current to the AD5625R/AD5645R/AD5665R and AD5625/AD5665 with no load on the output of the DAC. When the DAC output is loaded, the REF195 also must supply the current to the load. The total current required (with a 5 k $\Omega$  load on the DAC output) is

$$1 \text{ mA} + (5 \text{ V}/5 \text{ k}\Omega) = 2 \text{ mA}$$

The load regulation of the REF195 is typically 2 ppm/mA, resulting in a 4 ppm (20  $\mu$ V) error for the 2 mA current drawn from it. This corresponds to a 0.263 LSB error.

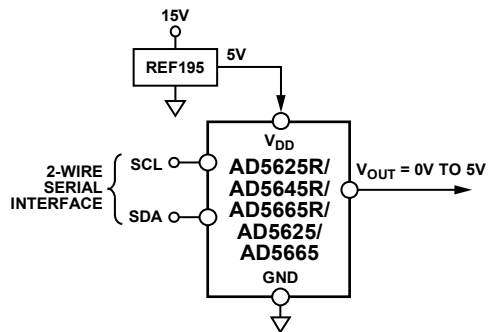


Figure 74. REF195 as Power Supply to the AD5625R/AD5645R/AD5665R and AD5625/AD5665

### BIPOLAR OPERATION USING THE AD5625R/AD5645R/AD5665R AND AD5625/AD5665

The AD5625R/AD5645R/AD5665R and AD5625/AD5665 have been designed for single-supply operation, but a bipolar output range is also possible using the circuit shown in Figure 75. The circuit gives an output voltage range of  $\pm 5$  V. Rail-to-rail operation at the amplifier output is achievable using an AD820 or an OP295 as the output amplifier.

The output voltage for any input code can be calculated as follows:

$$V_O = \left[ V_{DD} \times \left( \frac{D}{65,536} \right) \times \left( \frac{R1 + R2}{R1} \right) - V_{DD} \times \left( \frac{R2}{R1} \right) \right]$$

where  $D$  represents the input code in decimal (0 to 65,535).

If  $V_{DD} = 5$  V,  $R1 = R2 = 10$  k $\Omega$ ,

$$V_O = \left( \frac{10 \times D}{65,536} \right) - 5 \text{ V}$$

This is an output voltage range of  $\pm 5$  V, with 0x0000 corresponding to a  $-5$  V output and 0xFFFF corresponding to a  $+5$  V output.

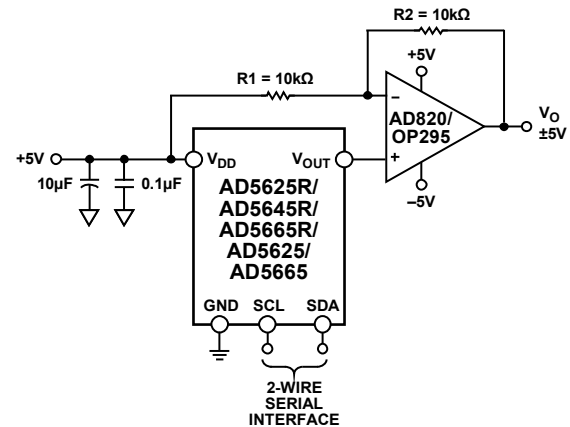


Figure 75. Bipolar Operation with the AD5625R/AD5645R/AD5665R and AD5625/AD5665

### POWER SUPPLY BYPASSING AND GROUNDING

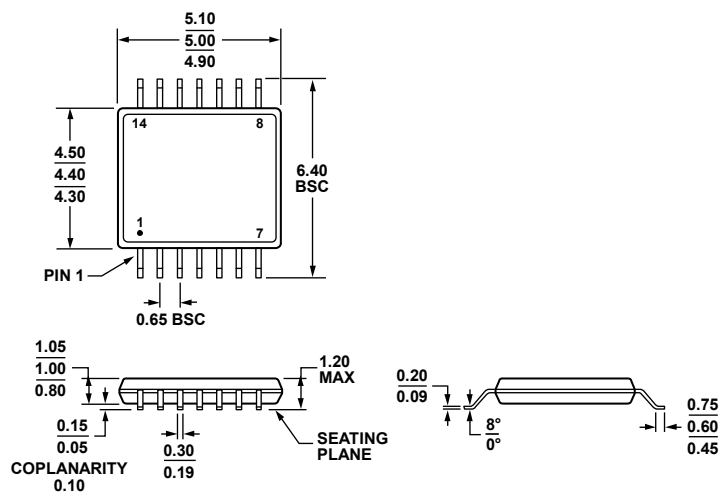
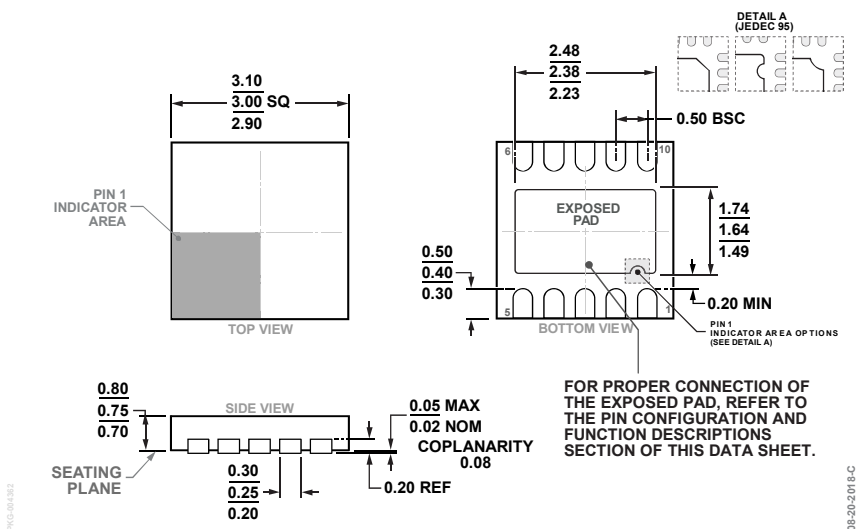
When accuracy is important in a circuit, it is helpful to carefully consider the power supply and ground return layout on the board. The printed circuit board containing the AD5625R/AD5645R/AD5665R and AD5625/AD5665 should have separate analog and digital sections, each having its own area of the board. If the AD5625R/AD5645R/AD5665R and AD5625/AD5665 are in a system where other devices require an AGND-to-DGND connection, the connection should be made at one point only. This ground point should be as close as possible to the AD5625R/AD5645R/AD5665R and AD5625/AD5665.

The power supply to the AD5625R/AD5645R/AD5665R and AD5625/AD5665 should be bypassed with 10  $\mu$ F and 0.1  $\mu$ F capacitors. The capacitors should be located as close as possible to the device, with the 0.1  $\mu$ F capacitor ideally right up against the device. The 10  $\mu$ F capacitor is the tantalum bead type. It is important that the 0.1  $\mu$ F capacitor have low effective series resistance (ESR) and low effective series inductance (ESI), for example, common ceramic types of capacitors. This 0.1  $\mu$ F capacitor provides a low impedance path to ground for high frequencies caused by transient currents due to internal logic switching.

The power supply line itself should have as large a trace as possible to provide a low impedance path and to reduce glitch effects on the supply line. Clocks and other fast switching digital signals should be shielded from other parts of the board by digital ground. Avoid crossover of digital and analog signals if possible. When traces cross on opposite sides of the board, ensure that they run at right angles to each other to reduce feedthrough effects through the board. The best board layout technique is the microstrip technique where the component side of the board is dedicated to the ground plane only, and the signal traces are placed on the solder side. However, this is not always possible with a 2-layer board.



## OUTLINE DIMENSIONS



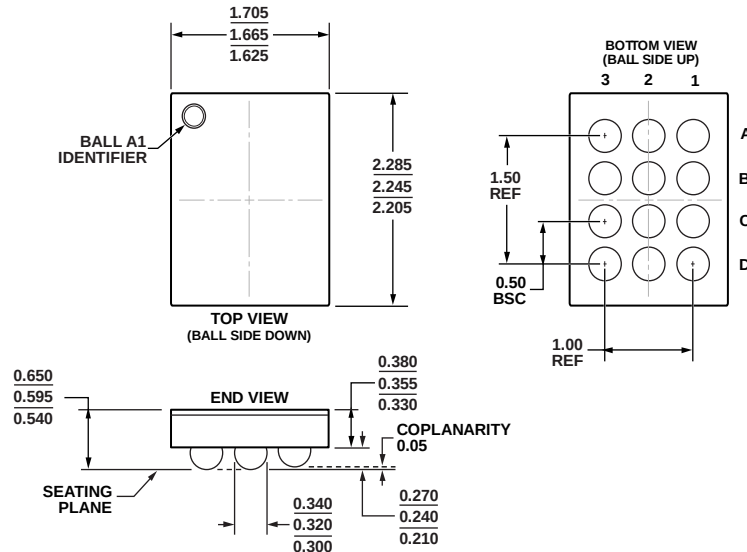


Figure 78. 12-Ball Wafer Level Chip Scale Package [WLCSP]  
(CB-12-9)  
Dimensions shown in millimeters

## ORDERING GUIDE

| Model <sup>1</sup> | Temperature Range | Accuracy    | On-Chip Reference | Maximum I <sup>2</sup> C Speed | Package Description | Package Option | Marking Code |
|--------------------|-------------------|-------------|-------------------|--------------------------------|---------------------|----------------|--------------|
| AD5625BCPZ-R2      | −40°C to +105°C   | ±1 LSB INL  | None              | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D8V          |
| AD5625BCPZ-REEL7   | −40°C to +105°C   | ±1 LSB INL  | None              | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D8V          |
| AD5625BRUZ         | −40°C to +105°C   | ±1 LSB INL  | None              | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5625BRUZ-REEL7   | −40°C to +105°C   | ±1 LSB INL  | None              | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5625RBCPZ-R2     | −40°C to +105°C   | ±1 LSB INL  | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D8S          |
| AD5625RBCPZ-REEL7  | −40°C to +105°C   | ±1 LSB INL  | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D8S          |
| AD5625RACPZ-REEL7  | −40°C to +105°C   | ±4 LSB INL  | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | DEU          |
| AD5625RBRUZ-1      | −40°C to +105°C   | ±1 LSB INL  | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5625RBRUZ-1REEL7 | −40°C to +105°C   | ±1 LSB INL  | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5625RBRUZ-2      | −40°C to +105°C   | ±1 LSB INL  | 2.5 V             | 3.4 MHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5625RBRUZ-2REEL7 | −40°C to +105°C   | ±1 LSB INL  | 2.5 V             | 3.4 MHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5645RBCPZ-R2     | −40°C to +105°C   | ±4 LSB INL  | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D89          |
| AD5645RBCPZ-REEL7  | −40°C to +105°C   | ±4 LSB INL  | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D89          |
| AD5645RBRUZ        | −40°C to +105°C   | ±4 LSB INL  | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5645RBRUZ-REEL7  | −40°C to +105°C   | ±4 LSB INL  | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665BCPZ-R2      | −40°C to +105°C   | ±16 LSB INL | None              | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D6U          |
| AD5665BCPZ-REEL7   | −40°C to +105°C   | ±16 LSB INL | None              | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | D6U          |
| AD5665BRUZ         | −40°C to +105°C   | ±16 LSB INL | None              | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665BRUZ-REEL7   | −40°C to +105°C   | ±16 LSB INL | None              | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665RBCBZ-1-RL7  | −40°C to +105°C   | ±16 LSB INL | 1.25 V            | 400 kHz                        | 12-Ball WLCSP       | CB-12-9        |              |
| AD5665RBCPZ-R2     | −40°C to +105°C   | ±16 LSB INL | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | DA2          |
| AD5665RBCPZ-REEL7  | −40°C to +105°C   | ±16 LSB INL | 1.25 V            | 400 kHz                        | 10-Lead LFCSP       | CP-10-9        | DA2          |
| AD5665RBRUZ-1      | −40°C to +105°C   | ±16 LSB INL | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665RBRUZ-1REEL7 | −40°C to +105°C   | ±16 LSB INL | 2.5 V             | 400 kHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665RBRUZ-2      | −40°C to +105°C   | ±16 LSB INL | 2.5 V             | 3.4 MHz                        | 14-Lead TSSOP       | RU-14          |              |
| AD5665RBRUZ-2REEL7 | −40°C to +105°C   | ±16 LSB INL | 2.5 V             | 3.4 MHz                        | 14-Lead TSSOP       | RU-14          |              |

<sup>1</sup> Z = RoHS Compliant Part.

## NOTES

I<sup>2</sup>C refers to a communications protocol originally developed by Philips Semiconductors (now NXP Semiconductors).

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9